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MB95F332H/F332K/F333H/F333K/F334H/F334K

F²MC-8FX MB95330H Series 8-bit Microcontrollers

MB95330H is a series of general-purpose, single-chip microcontrollers. In addition to a compact instruction set, the microcontrollers of this series contain a variety of peripheral resources.

Features

F²MC-8FX CPU core

Instruction set optimized for controllers

- Multiplication and division instructions
- 16-bit arithmetic operations
- Bit test branch instructions
- Bit manipulation instructions, etc.

Clock

■ Selectable main clock source

Main OSC clock (up to 16.25 MHz, maximum machine clock frequency: 8.125 MHz)

External clock (up to 32.5 MHz, maximum machine clock frequency: 16.25 MHz)

Main CR clock (1/8/10/12.5 MHz ±2%, maximum machine clock frequency: 12.5 MHz)

 Selectable subclock source Sub-OSC clock (32.768 kHz)
 External clock (32.768 kHz)

Sub-CR clock (Typ: 100 kHz, Min: 50 kHz, Max: 200 kHz)

Timer

- 8/16-bit composite timer × 2 channels
- 8/16-bit PPG × 3 channels
- 16-bit PPG × 1 channel (can work independently or together with the multi-pulse generator)
- 16-bit reload timer × 1 channel (can work independently or together with the multi-pulse generator)
- Time-base timer × 1 channel
- Watch prescaler × 1 channel

UART/SIO × 1 channel

- Full duplex double buffer
- Capable of clock-asynchronous (UART) serial data transfer and clock-synchronous (SIO) serial data transfer

I²C × 1 channel

■ Built-in wake-up function

Multi-pulse generator (MPG) (for DC motor control) × 1 channel

- 16-bit reload timer × 1 channel
- 16-bit PPG timer × 1 channel
- Waveform sequencer (including a 16-bit timer equipped with a buffer and a compare clear function)

LIN-UART

- Full duplex double buffer
- Capable of clock-synchronous serial data transfer and clock-asynchronous serial data transfer

External interrupt × 10 channels

- Interrupt by edge detection (rising edge, falling edge, and both edges can be selected)
- Can be used to wake up the device from different low power consumption (standby) modes

8/10-bit A/D converter × 8 channels

■ 8-bit and 10-bit resolution can be chosen.

Low power consumption (standby) modes

- Stop mode
- Sleep mode
- Watch mode
- Time-base timer mode

I/O port

- MB95F332H/F333H/F334H (maximum no. of I/O ports: 28)
 General-purpose I/O ports (N-ch open drain): 3
 General-purpose I/O ports (CMOS I/O): 25
- MB95F332K/F333K/F334K (maximum no. of I/O ports: 29) General-purpose I/O ports (N-ch open drain): 4 General-purpose I/O ports (CMOS I/O): 25

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On-chip debug

- 1-wire serial control
- Serial writing supported (asynchronous mode)

Hardware/software watchdog timer

■ Built-in hardware watchdog timer

Low-voltage detection reset circuit

■ Built-in low-voltage detector

Clock supervisor counter

■ Built-in clock supervisor counter function

Programmable port input voltage level

■ CMOS input level / hysteresis input level

Dual operation Flash memory

■ The erase/write operation and the read operation can be executed in different banks (upper bank/lower bank) simultaneously.

Flash memory security function

■ Protects the content of the Flash memory



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1. Product Line-up

Part number	•										
	MB95F332H	MB95F333H	MB95F334H	MB95F332K	MB95F333K	MB95F334K					
Parameter											
Туре		Flash memory product									
Clock supervisor counter	It supervises the m	ain clock oscillation	l.								
Program ROM ca- pacity	8 Kbyte	12 Kbyte	20 Kbyte	8 Kbyte	12 Kbyte	20 Kbyte					
RAM capacity	240 bytes	496 bytes	1008 bytes	240 bytes	496 bytes	1008 bytes					
Low-voltage detection reset		No Yes									
Reset input		Dedicated			Selected by software	е					
CPU functions	Instruction bit lengt Instruction length Data bit length Minimum instructio	struction length : 1 to 3 bytes									
General-purpose I/O	I/O ports (Max): 28 CMOS I/O: 25 N-ch open drain: 3	CMOS I/O: 25 CMOS I/O: 25									
Time-base timer	Interrupt cycle: 0.2	56 ms to 8.3 s (whe	en external clock = 4	4 MHz)							
Hardware/software watchdog timer	Reset generation of Main oscillation clo The sub-CR clock (ck at 10 MHz: 105		hardware watchdo	g timer.						
Wild register	It can be used to re	place three bytes o	of data.								
LIN-UART	Clock-synchronous	wide range of communication speeds can be selected by a dedicated reload timer. Clock-synchronous serial data transfer and clock-asynchronous serial data transfer is enabled. The LIN function can be used as a LIN master or a LIN slave.									
8/10-bit A/D con-	8 channels										
verter	3-bit resolution and 10-bit resolution can be chosen.										
	2 channels										
8/16-bit composite timer	The timer can be configured as an "8-bit timer x 2 channels" or a "16-bit timer x 1 channel". It has built-in timer function, PWC function, PWM function and input capture function. Count clock: it can be selected from internal clocks (seven types) and external clocks. It can output square wave.										
External	10 channels										
External interrupt		terrupt by edge detection (The rising edge, falling edge, or both edges can be selected.) can be used to wake up the device from different standby modes.									
On-chip debug	1-wire serial contro It supports serial w	·									



Part number									
	MB95F332H	MB95F333H	MB95F334H	MB95F332K	MB95F333K	MB95F334K			
Parameter									
	1 channel								
UART/SIO	It has a full duplex tection function. It uses the NRZ typ LSB-first data trans	Data transfer with UART/SIO is enabled. It has a full duplex double buffer, variable data length (5/6/7/8 bits), a built-in baud rate generator and an error detection function. It uses the NRZ type transfer format. LSB-first data transfer and MSB-first data transfer are available to use. Clock-asynchronous (UART) serial data transfer and clock-synchronous (SIO) serial data transfer is enabled.							
	1 channel								
l ² C	It also has function	nction, an arbitratio	ng on function, a transm I detecting repeated			a wake-up function.			
	3 channels								
8/16-bit PPG			two 8-bit PPG char elected from eight cl		-bit PPG channel.				
16-bit PPG	PWM mode and one-shot mode are available to use. The counter operating clock can be selected from eight clock sources. It supports external trigger start. It can work independently or together with the multi-pulse generator.								
16-bit reload timer	Two clock modes and two counter operating modes are available to use. It can output square waveform. Count clock: it can be selected from internal clocks (seven types) and external clocks. Two counter operating modes: reload mode and one-shot mode It can work independently or together with the multi-pulse generator.								
Multi-pulse genera- tor (for DC motor control)	16-bit PPG timer: 1 channel 16-bit reload timer operations: toggle output, one-shot output Event counter: 1 channel Waveform sequencer (including a 16-bit timer equipped with a buffer and a compare clear function)								
Watch prescaler	Eight different time intervals can be selected.								
Flash memory	It supports automatic programming, Embedded Algorithm, and write/erase/erase-suspend/erase-resume commands. It has a flag indicating the completion of the operation of Embedded Algorithm. Number of write/erase cycles: 100000 Data retention time: 20 years Flash security feature for protecting the content of the Flash memory								
Standby mode	Sleep mode, stop mode, watch mode, time-base timer mode								
Package				2P-M30 2P-M06 2P-M19					



2. Packages and Corresponding Products

Part number Package	MB95F332H	MB95F332K	MB95F333H	MB95F333K	MB95F334H	MB95F334K
FPT-32P-M30	0	0	0	0	0	0
DIP-32P-M06	0	0	0	0	0	0
LCC-32P-M19	0	0	0	0	0	0

O: Available

3. Differences Among Products and Notes On Product Selection

■ • Current consumption

When using the on-chip debug function, take account of the current consumption of flash erase/write. For details of current consumption, see "Electrical Characteristics."

Package

For details of information on each package, see "Packages and Corresponding Products" and "Package Dimension".

■ • Operating voltage

The operating voltage varies, depending on whether the on-chip debug function is used or not.

For details of the operating voltage, see "Electrical Characteristics".

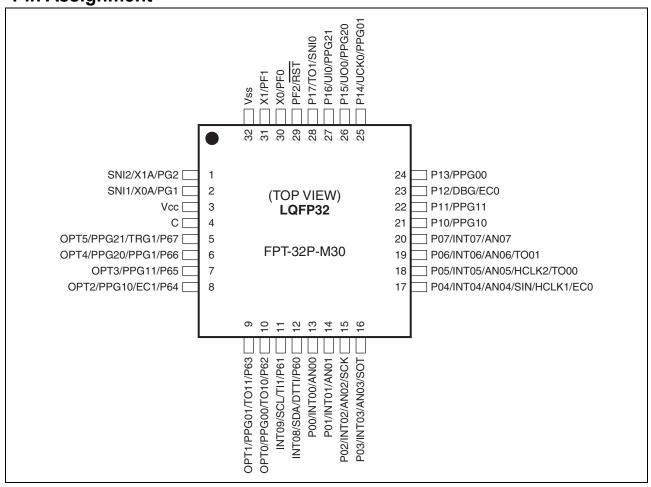
■ • On-chip debug function

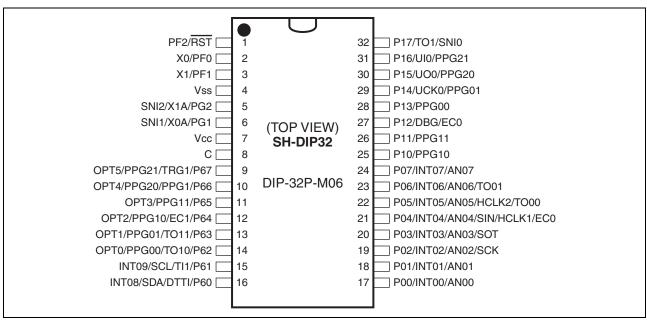
The on-chip debug function requires that V_{CC}, V_{SS} and one serial wire be connected to an evaluation tool.

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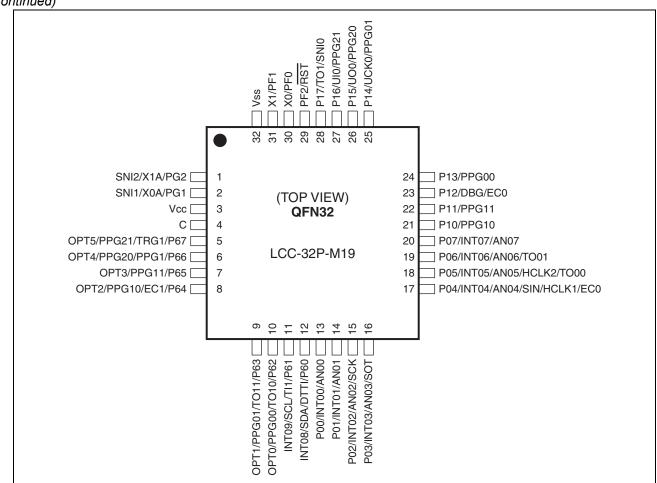
4. Pin Assignment













5. Pin Description

Pin	no.		I/O	
LQFP32* ¹ & QFN32* ²	SH-DIP32*3	Pin circuit type*4		Function
		PG2		General-purpose I/O port
1	5	X1A	С	Subclock I/O oscillation pin
		SNI2		Trigger input pin for the position detection function of the MPG waveform sequencer
		PG1		General-purpose I/O port
2	2 6		С	Subclock input oscillation pin
_	•	SNI1		Trigger input pin for the position detection function of the MPG waveform sequencer
3	7	V _{CC}	_	Power supply pin
4	8	С	_	Capacitor connection pin
		P67		General-purpose I/O port High-current pin
5	9	PPG21	D	8/16-bit PPG ch. 2 output pin
		TRG1		16-bit PPG ch. 1 trigger input pin
		OPT5		MPG waveform sequencer output pin
		P66	D	General-purpose I/O port High-current pin
6	10	PPG20		8/16-bit PPG ch. 2 output pin
		PPG1		16-bit PPG ch. 1 output pin
		OPT4		MPG waveform sequencer output pin
		P65		General-purpose I/O port High-current pin
7	11	PPG11	D	8/16-bit PPG ch. 1 output pin
		OPT3		MPG waveform sequencer output pin
		P64		General-purpose I/O port High-current pin
8	12	EC1	D	8/16-bit composite timer ch. 1 clock input pin
		PPG10		8/16-bit PPG ch. 1 output pin
		OPT2		MPG waveform sequencer output pin
		P63		General-purpose I/O port High-current pin
9	13	TO11	D	8/16-bit composite timer ch. 1 output pin
		PPG01		8/16-bit PPG ch. 0 output pin
		OPT1		MPG waveform sequencer output pin



Pin no.			I/O	
LQFP32* ¹ & QFN32* ²	SH-DIP32*3	Pin circuit type*4		Function
		P62		General-purpose I/O port High-current pin
10	14	TO10	D	8/16-bit composite timer ch. 1 output pin
		PPG00		8/16-bit PPG ch. 0 output pin
		OPT0		MPG waveform sequencer output pin
		P61		General-purpose I/O port
11	15	INT09		External interrupt input pin
11	15	SCL] '	I ² C clock I/O pin
		TI1		16-bit reload timer ch. 1 input pin
		P60		General-purpose I/O port
12	16	INT08		External interrupt input pin
12	16	SDA	'	I ² C data I/O pin
		DTTI		MPG waveform sequencer input pin
		P00		General-purpose I/O port
13	17	INT00	E	External interrupt input pin
		AN00		A/D converter analog input pin
		P01		General-purpose I/O port
14	18	INT01	E	External interrupt input pin
		AN01		A/D converter analog input pin
		P02		General-purpose I/O port
15	19	INT02	E	External interrupt input pin
15	19	AN02		A/D converter analog input pin
		SCK		LIN-UART clock I/O pin
		P03		General-purpose I/O port
16	20	INT03	E	External interrupt input pin
10	20	AN03		A/D converter analog input pin
		SOT		LIN-UART data output pin
47		P04		General-purpose I/O port
		INT04		External interrupt input pin
	24	AN04	_	A/D converter analog input pin
17	21	SIN	F	LIN-UART data input pin
		HCLK1		External clock input pin
		EC0		8/16-bit composite timer ch. 0 clock input pin



Pin	Pin no.		I/O					
LQFP32* ¹ & QFN32* ²	SH-DIP32*3	Pin circuit type*4		Function				
		P05		General-purpose I/O port				
		INT05		External interrupt input pin				
18	22	AN05	E	A/D converter analog input pin				
		HCLK2		External clock input pin				
		TO00		8/16-bit composite timer ch. 0 output pin				
		P06		General-purpose I/O port				
19	23	INT06	E	External interrupt input pin				
19	23	AN06		A/D converter analog input pin				
		TO01		8/16-bit composite timer ch. 0 output pin				
		P07		General-purpose I/O port				
20	24	INT07	E	External interrupt input pin				
		AN07		A/D converter analog input pin				
21	25	P10	G	General-purpose I/O port				
21	23	PPG10		8/16-bit PPG ch. 1 output pin				
22	26	P11 G	General-purpose I/O port					
22	20	PPG11		8/16-bit PPG ch. 1 output pin				
	27	P12		General-purpose I/O port				
23		27	27	27	27	27	27 DBG	Н
		EC0		8/16-bit composite timer ch. 0 clock input pin				
24	28	P13	G	General-purpose I/O port				
24	20	PPG00		8/16-bit PPG ch. 0 output pin				
		P14		General-purpose I/O port				
25	29	UCK0	G	UART/SIO ch. 0 clock I/O pin				
		PPG01		8/16-bit PPG ch. 0 output pin				
		P15		General-purpose I/O port				
26	30	UO0	G	UART/SIO ch. 0 data output pin				
		PPG20		8/16-bit PPG ch. 2 output pin				
		P16		General-purpose I/O port				
27	31	UI0	J	UART/SIO ch. 0 data input pin				
				8/16-bit PPG ch. 2 output pin				
		P17		General-purpose I/O port				
28	32	TO1	G	16-bit reload timer ch. 1 output pin				
		SNI0		Trigger input pin for the position detection function of the MPG waveform sequencer				
		PF2		General-purpose I/O port				
29	1	RST	А	Reset pin Dedicated reset pin in MB95F332H/F333H/F334H				



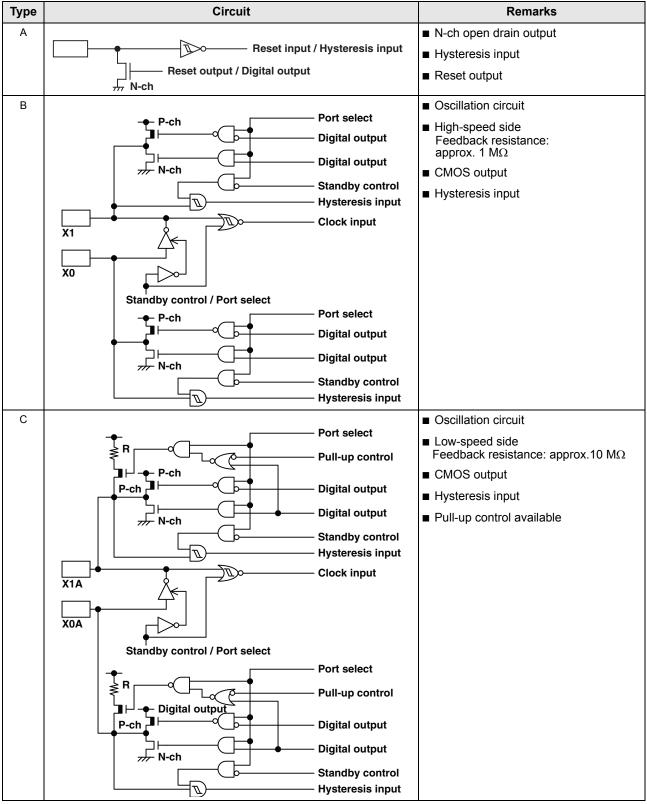
Pin	no.			
LQFP32* ¹ & QFN32* ²	SH-DIP32*3	Pin name	circuit type* ⁴	Function
30	2	PF0	В	General-purpose I/O port
30	2	X0	В	Main clock input oscillation pin
31	3	PF1	В	General-purpose I/O port
31	S	X1	В	Main clock I/O oscillation pin
32	4	V _{SS}	_	Power supply pin (GND)

*1: Package code: FPT-32P-M30*2: Package code: LCC-32P-M19*3: Package code: DIP-32P-M06

*4: For the I/O circuit types, see "I/O Circuit Type".



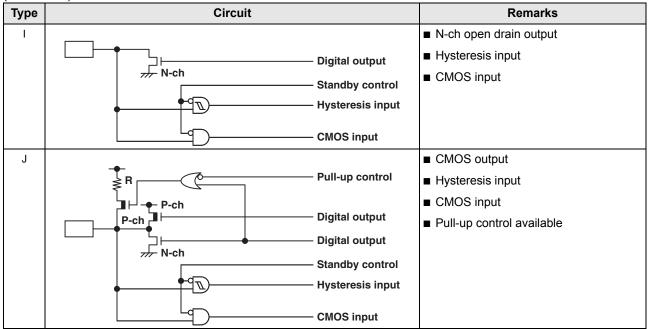
6. I/O Circuit Type





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Digital output		└ Digital output		
- N-ch				





7. Notes On Device Handling

■ Preventing latch-ups

When using the device, ensure that the voltage applied does not exceed the maximum voltage rating.

In a CMOS IC, if a voltage higher than V_{CC} or a voltage lower than V_{SS} is applied to an input/output pin that is neither a medium-withstand voltage pin nor a high-withstand voltage pin, or if a voltage out of the rating range of power supply voltage mentioned in "13.1 Absolute Maximum Ratings" of " \blacksquare Electrical Characteristics" is applied to the V_{CC} pin or the V_{SS} pin, a latch-up may occur.

When a latch-up occurs, power supply current increases significantly, which may cause a component to be thermally destroyed.

■ Stabilizing supply voltage

Supply voltage must be stabilized.

A malfunction may occur when power supply voltage fluctuates rapidly even though the fluctuation is within the guaranteed operating range of the V_{CC} power supply voltage.

As a rule of voltage stabilization, suppress voltage fluctuation so that the fluctuation in V_{CC} ripple (p-p value) at the commercial frequency (50 Hz/60 Hz) does not exceed 10% of the standard V_{CC} value, and the transient fluctuation rate does not exceed 0.1 V/ms at a momentary fluctuation such as switching the power supply.

■ Notes on using the external clock

When an external clock is used, oscillation stabilization wait time is required for power-on reset, wake-up from subclock mode or stop mode.

8. Pin Connection

■ Treatment of unused pins

If an unused input pin is left unconnected, a component may be permanently damaged due to malfunctions or latch-ups. Always pull up or pull down an unused input pin through a resistor of at least $2 \text{ k}\Omega$. Set an unused input/output pin to the output state and leave it unconnected, or set it to the input state and treat it the same as an unused input pin. If there is an unused output pin, leave it unconnected.



■ Power supply pins

To reduce unnecessary electro-magnetic emission, prevent malfunctions of strobe signals due to an increase in the ground level, and conform to the total output current standard, always connect the V_{CC} pin and the V_{SS} pin to the power supply and ground outside the device. In addition, connect the current supply source to the V_{CC} pin and the V_{SS} pin with low impedance.

It is also advisable to connect a ceramic capacitor of approximately 0.1 μ F as a bypass capacitor between the V_{CC} pin and the V_{SS} pin at a location close to this device.

■ DBG pin

Connect the DBG pin directly to an external pull-up resistor.

To prevent the device from unintentionally entering the debug mode due to noise, minimize the distance between the DBG pin and the V_{CC} or V_{SS} pin when designing the layout of the printed circuit board.

The DBG pin should not stay at "L" level after power-on until the reset output is released.

■ RST pin

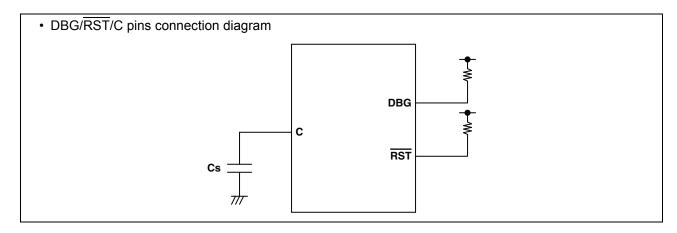
Connect the RST pin directly to an external pull-up resistor.

To prevent the device from unintentionally entering the reset mode due to noise, minimize the distance between the \overline{RST} pin and the V_{CC} or V_{SS} pin when designing the layout of the printed circuit board.

The RST/PF2 pin functions as the reset input/output pin after power-on. In addition, the reset output of the RST/PF2 pin can be enabled by the RSTOE bit of the SYSC register, and the reset input function and the general purpose I/O function can be selected by the RSTEN bit of the SYSC register.

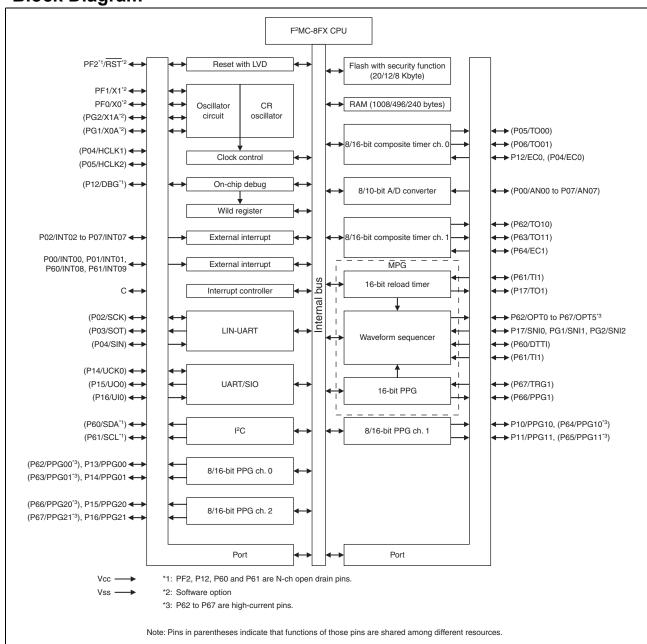
■ C pin

Use a ceramic capacitor or a capacitor with equivalent frequency characteristics. The bypass capacitor for the V_{CC} pin must have a capacitance larger than C_S . For the connection to a smoothing capacitor C_S , see the diagram below. To prevent the device from unintentionally entering a mode to which the device is not set to transit due to noise, minimize the distance between the C pin and C_S and the distance between C_S and the V_{SS} pin when designing the layout of a printed circuit board.





9. Block Diagram



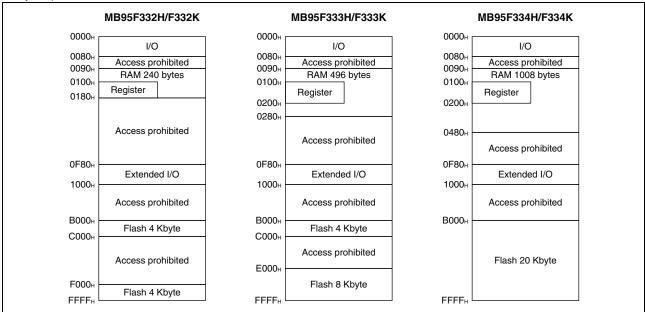
10. CPU Core

■ Memory Space

The memory space of the MB95330H Series is 64 Kbyte in size, and consists of an I/O area, a data area, and a program area. The memory space includes areas intended for specific purposes such as general-purpose registers and a vector table. The memory maps of the MB95330H Series are shown below.



■ Memory Maps





11. I/O Map

Address	Register abbreviation	Register name	R/W	Initial value
0000 _H	PDR0	Port 0 data register	R/W	00000000 _B
0001 _H	DDR0	Port 0 direction register	R/W	00000000 _B
0002 _H	PDR1	Port 1 data register	R/W	00000000 _B
0003 _H	DDR1	Port 1 direction register	R/W	00000000 _B
0004 _H	_	(Disabled)		_
0005 _H	WATR	Oscillation stabilization wait time setting register	R/W	11111111 _B
0006 _H	_	(Disabled)	_	_
0007 _H	SYCC	System clock control register	R/W	0000X011 _B
0008 _H	STBC	Standby control register	R/W	00000XXX _B
0009 _H	RSRR	Reset source register	R/W	XXXXXXXX _B
000A _H	TBTC	Time-base timer control register	R/W	00000000 _B
000B _H	WPCR	Watch prescaler control register	R/W	00000000 _B
000C _H	WDTC	Watchdog timer control register	R/W	00XX0000 _B
000D _H	SYCC2	System clock control register 2	R/W	XX100011 _B
000E _H				
to	_	(Disabled)	-	_
0015 _H	PDR6	Port 6 data register	R/W	0000000
0016 _H		Port 6 data register	R/W	00000000 _B
0017 _H	DDR6	Port 6 direction register	R/VV	00000000 _B
0018 _H to	_	(Disabled)	_	_
0027 _H		(,		
0028 _H	PDRF	Port F data register	R/W	00000000 _B
0029 _H	DDRF	Port F direction register	R/W	00000000 _B
002A _H	PDRG	Port G data register	R/W	00000000 _B
002B _H	DDRG	Port G direction register	R/W	00000000 _B
002C _H	PUL0	Port 0 pull-up register	R/W	00000000 _B
002D _H	PUL1	Port 1 pull-up register	R/W	00000000 _B
002E _H				
to 0034 _H	_	(Disabled)	-	_
0034 _H	PULG	Port G pull-up register	R/W	00000000 _B
0035 _H	T01CR1	8/16-bit composite timer 01 status control register 1 ch. 0	R/W	00000000 _B
0037 _H	T00CR1	8/16-bit composite timer 01 status control register 1 ch. 0	R/W	00000000B
0037 _H	T11CR1	8/16-bit composite timer 11 status control register 1 ch. 1	R/W	00000000B
0039 _H	T10CR1	8/16-bit composite timer 10 status control register 1 ch. 1	R/W	00000000B
0039 _H	PC01	8/16-bit PPG timer 01 control register ch. 0	R/W	00000000 _B
003A _H	PC00	8/16-bit PPG timer 00 control register ch. 0	R/W	00000000 _B
003B _H	PC11	8/16-bit PPG timer 11 control register ch. 1	R/W	00000000 _B
003C _H	PC10	8/16-bit PPG timer 10 control register ch. 1	R/W	00000000 _B
003D _H	PC10 PC21	8/16-bit PPG timer 21 control register ch. 2	R/W	00000000 _B
003E _H	PC21	8/16-bit PPG timer 20 control register ch. 2	R/W	00000000 _B



Address	Register abbreviation	Register name	R/W	Initial value
0040 _H	TMCSRH1	16-bit reload timer control status register upper ch. 1	R/W	00000000 _B
0041 _H	TMCSRL1	16-bit reload timer control status register lower ch. 1	R/W	00000000 _B
0042 _H , 0043 _H	_	(Disabled)	_	_
0044 _H	PCNTH1	16-bit PPG status control register upper ch. 1	R/W	00000000 _B
0045 _H	PCNTL1	16-bit PPG status control register lower ch. 1	R/W	00000000 _B
0046 _H , 0047 _H	_	(Disabled)	_	_
0048 _H	EIC00	External interrupt circuit control register ch. 0/ch. 1	R/W	00000000 _B
0049 _H	EIC10	External interrupt circuit control register ch. 2/ch. 3	R/W	00000000 _B
004A _H	EIC20	External interrupt circuit control register ch. 4/ch. 5	R/W	00000000 _B
004B _H	EIC30	External interrupt circuit control register ch. 6/ch. 7	R/W	00000000 _B
004C _H	EIC01	External interrupt circuit control register ch. 8/ch. 9	R/W	00000000 _B
004D _H to 004F _H	_	(Disabled)	_	_
0050 _H	SCR	LIN-UART serial control register	R/W	00000000 _B
0051 _H	SMR	LIN-UART serial mode register	R/W	00000000 _B
0052 _H	SSR	LIN-UART serial status register	R/W	00001000 _B
0053 _H	RDR/TDR	LIN-UART receive/transmit data register	R/W	00000000 _B
0054 _H	ESCR	LIN-UART extended status control register	R/W	00000100 _B
0055 _H	ECCR	LIN-UART extended communication control register	R/W	000000XX _B
0056 _H	SMC10	UART/SIO serial mode control register 1 ch. 0	R/W	00000000 _B
0057 _H	SMC20	UART/SIO serial mode control register 2 ch. 0	R/W	00100000 _B
0058 _H	SSR0	UART/SIO serial status and data register ch. 0	R/W	00000001 _B
0059 _H	TDR0	UART/SIO serial output data register ch. 0	R/W	00000000 _B
005A _H	RDR0	UART/SIO serial input data register ch. 0	R	00000000 _B
005B _H to 005F _H	_	(Disabled)	_	_
0060 _H	IBCR00	I ² C bus control register 0	R/W	00000000 _B
0061 _H	IBCR10	I ² C bus control register 1	R/W	00000000 _B
0062 _H	IBSR0	I ² C bus status register	R/W	00000000 _B
0063 _H	IDDR0	I ² C data register	R/W	00000000 _B
0064 _H	IAAR0	I ² C address register	R/W	00000000 _B
0065 _H	ICCR0	I ² C clock control register	R/W	00000000 _B
0066 _H	OPCUR	16-bit MPG output control register (upper)	R/W	00000000 _B
0067 _H	OPCLR	16-bit MPG output control register (lower)	R/W	00000000 _B
0068 _H	IPCUR	16-bit MPG input control register (upper)	R/W	00000000 _B
0069 _H	IPCLR	16-bit MPG input control register (lower)	R/W	00000000 _B



Address	Register abbreviation	Register name	R/W	Initial value
006A _H	NCCR	16-bit MPG noise cancellation control register	R/W	00000000 _B
006B _H	TCSR	16-bit MPG timer control status register	R/W	00000000 _B
006C _H	ADC1	8/10-bit A/D converter control register 1	R/W	00000000 _B
006D _H	ADC2	8/10-bit A/D converter control register 2	R/W	00000000 _B
006E _H	ADDH	8/10-bit A/D converter data register (upper)	R/W	00000000 _B
006F _H	ADDL	8/10-bit A/D converter data register (lower)	R/W	00000000 _B
0070 _H	_	(Disabled)	_	_
0071 _H	FSR2	Flash memory status register 2	R/W	00000000 _B
0072 _H	FSR	Flash memory status register	R/W	000X0000 _B
0073 _H	SWRE0	Flash memory sector write control register 0	R/W	00000000 _B
0074 _H	FSR3	Flash memory status register 3	R	0000XXXX _B
0075 _H	_	(Disabled)	_	_
0076 _H	WREN	Wild register address compare enable register	R/W	00000000 _B
0077 _H	WROR	Wild register data test setting register	R/W	00000000 _B
0078 _H	_	Mirror of register bank pointer (RP) and mirror of direct bank pointer (DP)	_	_
0079 _H	ILR0	Interrupt level setting register 0	R/W	11111111 _B
007A _H	ILR1	Interrupt level setting register 1	R/W	11111111 _B
007B _H	ILR2	Interrupt level setting register 2	R/W	11111111 _B
007C _H	ILR3	Interrupt level setting register 3	R/W	11111111 _B
007D _H	ILR4	Interrupt level setting register 4	R/W	11111111 _B
007E _H	ILR5	Interrupt level setting register 5	R/W	11111111 _B
007F _H	_	(Disabled)	_	_
0F80 _H	WRARH0	Wild register address setting register (upper) ch. 0	R/W	00000000 _B
0F81 _H	WRARL0	Wild register address setting register (lower) ch. 0	R/W	00000000 _B
0F82 _H	WRDR0	Wild register data setting register ch. 0	R/W	00000000 _B
0F83 _H	WRARH1	Wild register address setting register (upper) ch. 1	R/W	00000000 _B
0F84 _H	WRARL1	Wild register address setting register (lower) ch. 1	R/W	00000000 _B
0F85 _H	WRDR1	Wild register data setting register ch. 1	R/W	00000000 _B
0F86 _H	WRARH2	Wild register address setting register (upper) ch. 2	R/W	00000000 _B
0F87 _H	WRARL2	Wild register address setting register (lower) ch. 2	R/W	00000000 _B
0F88 _H	WRDR2	Wild register data setting register ch. 2	R/W	00000000 _B
0F89 _H to 0F91 _H	_	(Disabled)	_	_



Address	Register abbreviation	Register name	R/W	Initial value
0F92 _H	T01CR0	8/16-bit composite timer 01 status control register 0 ch. 0	R/W	00000000 _B
0F93 _H	T00CR0	8/16-bit composite timer 00 status control register 0 ch. 0	R/W	00000000 _B
0F94 _H	T01DR	8/16-bit composite timer 01 data register ch. 0	R/W	00000000 _B
0F95 _H	T00DR	8/16-bit composite timer 00 data register ch. 0	R/W	00000000 _B
0F96 _H	TMCR0	8/16-bit composite timer 00/01 timer mode control register ch. 0	R/W	00000000 _B
0F97 _H	T11CR0	8/16-bit composite timer 11 status control register 0 ch. 1	R/W	00000000 _B
0F98 _H	T10CR0	8/16-bit composite timer 10 status control register 0 ch. 1	R/W	00000000 _B
0F99 _H	T11DR	8/16-bit composite timer 11 data register ch. 1	R/W	00000000 _B
0F9A _H	T10DR	8/16-bit composite timer 10 data register ch. 1	R/W	00000000 _B
0F9B _H	TMCR1	8/16-bit composite timer 10/11 timer mode control register ch. 1	R/W	00000000 _B
0F9C _H	PPS01	8/16-bit PPG01 cycle setting buffer register ch. 0	R/W	11111111 _B
0F9D _H	PPS00	8/16-bit PPG00 cycle setting buffer register ch. 0	R/W	11111111 _B
0F9E _H	PDS01	8/16-bit PPG01 duty setting buffer register ch. 0	R/W	11111111 _B
0F9F _H	PDS00	8/16-bit PPG00 duty setting buffer register ch. 0	R/W	11111111 _B
0FA0 _H	PPS11	8/16-bit PPG11 cycle setting buffer register ch. 1	R/W	11111111 _B
0FA1 _H	PPS10	8/16-bit PPG10 cycle setting buffer register ch. 1	R/W	11111111 _B
0FA2 _H	PDS11	8/16-bit PPG11 duty setting buffer register ch. 1	R/W	11111111 _B
0FA3 _H	PDS10	8/16-bit PPG10 duty setting buffer register ch. 1	R/W	11111111 _B
0FA4 _H	PPGS	8/16-bit PPG startup register	R/W	00000000 _B
0FA5 _H	REVC	8/16-bit PPG output reverse register	R/W	00000000 _B
0FA6 _H	PPS21	8/16-bit PPG21 cycle setting buffer register ch. 2	R/W	11111111 _B
0FA7 _H	PPS20	8/16-bit PPG20 cycle setting buffer register ch. 2	R/W	11111111 _B
2512	TMRH1	16-bit timer register (upper) ch. 1	5.44	
0FA8 _H	TMRLRH1	16-bit reload register (upper) ch. 1	R/W	00000000 _B
2512	TMRL1	16-bit timer register (lower) ch. 1	5	
0FA9 _H	TMRLRL1	16-bit reload register (lower) ch. 1		00000000 _B
0FAA _H	PDS21	8/16-bit PPG21 duty setting buffer register ch. 2	R/W	11111111 _B
0FAB _H	PDS20	8/16-bit PPG20 duty setting buffer register ch. 2	R/W	11111111 _B
0FAC _H to 0FAF _H	_	(Disabled)	_	_
0FB0 _H	PDCRH1	16-bit PPG down counter register (upper) ch. 1	R	00000000 _B
0FB1 _H	PDCRL1	16-bit PPG down counter register (lower) ch. 1	R	00000000 _B
0FB2 _H	PCSRH1	16-bit PPG cycle setting buffer register (upper) ch. 1	R/W	11111111 _B
0FB3 _H	PCSRL1	16-bit PPG cycle setting buffer register (lower) ch. 1	R/W	11111111 _B
0FB4 _H	PDUTH1	16-bit PPG duty setting buffer register (upper) ch. 1	R/W	11111111 _B
0FB5 _H	PDUTL1	16-bit PPG duty setting buffer register (lower) ch. 1	R/W	11111111 _B



Address	Register abbreviation	Register name	R/W	Initial value
0FB6 _H	_	(Disabled)	_	_
0FBB _H	BGR1	LIN-UART baud rate generator register 1	R/W	00000000 _B
	BGR0		R/W	
0FBD _H	PSSR0	LIN-UART baud rate generator register 0	R/W	00000000 _B
0FBF _H	BRSR0	UART/SIO dedicated baud rate generator prescaler select register ch. 0	R/W	00000000 _B
	BRSRU	UART/SIO dedicated baud rate generator baud rate setting register ch. 0	IN/VV	00000000 _B
0FC0 _H to 0FC2 _H	_	(Disabled)	-	_
0FC3 _H	AIDRL	A/D input disable register (lower)	R/W	00000000 _B
0FC4 _H	OPDBRH0	16-bit MPG output data buffer register (upper) ch. 0	R/W	00000000 _B
0FC5 _H	OPDBRL0	16-bit MPG output data buffer register (lower) ch. 0	R/W	00000000 _B
0FC6 _H	OPDBRH1	16-bit MPG output data buffer register (upper) ch. 1	R/W	00000000 _B
0FC7 _H	OPDBRL1	16-bit MPG output data buffer register (lower) ch. 1	R/W	00000000 _B
0FC8 _H	OPDBRH2	16-bit MPG output data buffer register (upper) ch. 2	R/W	00000000 _B
0FC9 _H	OPDBRL2	16-bit MPG output data buffer register (lower) ch. 2	R/W	00000000 _B
0FCA _H	OPDBRH3	16-bit MPG output data buffer register (upper) ch. 3	R/W	00000000 _B
0FCB _H	OPDBRL3	16-bit MPG output data buffer register (lower) ch. 3	R/W	00000000 _B
0FCC _H	OPDBRH4	16-bit MPG output data buffer register (upper) ch. 4	R/W	00000000 _B
0FCD _H	OPDBRL4	16-bit MPG output data buffer register (lower) ch. 4	R/W	00000000 _B
0FCE _H	OPDBRH5	16-bit MPG output data buffer register (upper) ch. 5	R/W	00000000 _B
0FCF _H	OPDBRL5	16-bit MPG output data buffer register (lower) ch. 5	R/W	00000000 _B
0FD0 _H	OPDBRH6	16-bit MPG output data buffer register (upper) ch. 6	R/W	00000000 _B
0FD1 _H	OPDBRL6	16-bit MPG output data buffer register (lower) ch. 6	R/W	00000000 _B
0FD2 _H	OPDBRH7	16-bit MPG output data buffer register (upper) ch. 7	R/W	00000000 _B
0FD3 _H	OPDBRL7	16-bit MPG output data buffer register (lower) ch. 7	R/W	00000000 _B
0FD4 _H	OPDBRH8	16-bit MPG output data buffer register (upper) ch. 8	R/W	00000000 _B
0FD5 _H	OPDBRL8	16-bit MPG output data buffer register (lower) ch. 8	R/W	00000000 _B
0FD6 _H	OPDBRH9	16-bit MPG output data buffer register (upper) ch. 9	R/W	00000000 _B
0FD7 _H	OPDBRL9	16-bit MPG output data buffer register (lower) ch. 9	R/W	00000000 _B
0FD8 _H	OPDBRHA	16-bit MPG output data buffer register (upper) ch. A	R/W	00000000 _B
0FD9 _H	OPDBRLA	16-bit MPG output data buffer register (lower) ch. A	R/W	00000000 _B
0FDA _H	OPDBRHB	16-bit MPG output data buffer register (upper) ch. B	R/W	00000000 _B
0FDB _H	OPDBRLB	16-bit MPG output data buffer register (lower) ch. B	R/W	00000000 _B
0FDC _H	OPDUR	16-bit MPG output data register (upper)	R	0000XXXX _B
0FDD _H	OPDLR	16-bit MPG output data register (lower)	R	XXXXXXXX _B
0FDE _H	CPCUR	16-bit MPG compare clear register (upper)	R/W	XXXXXXXX _B
0FDF _H	CPCLR	16-bit MPG compare clear register (lower)	R/W	XXXXXXXX _B



Address	Register abbreviation	Register name	R/W	Initial value
0FE0 _H , 0FE1 _H	_	(Disabled)	_	_
0FE2 _H	TMBUR	16-bit MPG timer buffer register (upper)	R	XXXXXXXX _B
0FE3 _H	TMBLR	16-bit MPG timer buffer register (lower)	R	XXXXXXXX _B
0FE4 _H	CRTH	Main CR clock trimming register (upper)	R/W	0XXXXXXX _B
0FE5 _H	CRTL	Main CR clock trimming register (lower)	R/W	00XXXXXX _B
0FE6 _H , 0FE7 _H	_	(Disabled)	_	_
0FE8 _H	SYSC	System configuration register	R/W	11000011 _B
0FE9 _H	CMCR	Clock monitoring control register	R/W	00000000 _B
0FEA _H	CMDR	Clock monitoring data register	R	00000000 _B
0FEB _H	WDTH	Watchdog timer selection ID register (upper)	R	XXXXXXXX _B
0FEC _H	WDTL	Watchdog timer selection ID register (lower)	R	XXXXXXXX _B
0FED _H	_	(Disabled)	_	_
0FEE _H	ILSR	Input level select register	R/W	00000000 _B
0FEF _H	WICR	Interrupt pin control register	R/W	01000000 _B
0FF0 _H to 0FFF _H	_	(Disabled)	_	_

■ R/W access symbols

R/W : Readable / Writable

R : Read only W : Write only

■ Initial value symbols

0 : The initial value of this bit is "0".1 : The initial value of this bit is "1".

X : The initial value of this bit is indeterminate.

Note: Do not write to an address that is "(Disabled)". If a "(Disabled)" address is read, an indeterminate value is returned.



12. Interrupt Source Table

	1.4	Vector tab	le address	D'1	Priority order of
Interrupt source	Interrupt request number	Upper	Lower	Bit name of interrupt level setting register	interrupt sources of the same level (occurring simultaneously)
External interrupt ch. 0, ch. 4	IRQ00	FFFA _H	FFFB _H	L00 [1:0]	High
External interrupt ch. 1, ch. 5	IRQ01	FFF8 _H	FFF9 _H	L01 [1:0]	1 ▲
External interrupt ch. 2, ch. 6	IRQ02	FFF6 _H	FFF7 _H	L02 [1:0]]
External interrupt ch. 3, ch. 7	IRQ03	FFF4 _H	FFF5 _H	L03 [1:0]	
UART/SIO ch. 0, MPG (DTTI)	IRQ04	FFF2 _H	FFF3 _H	L04 [1:0]	
8/16-bit composite timer ch. 0 (lower)	IRQ05	FFF0 _H	FFF1 _H	L05 [1:0]	
8/16-bit composite timer ch. 0 (upper)	IRQ06	FFEE _H	FFEF _H	L06 [1:0]	
LIN-UART (reception)	IRQ07	FFEC _H	FFED _H	L07 [1:0]	
LIN-UART (transmission)	IRQ08	FFEA _H	FFEB _H	L08 [1:0]	
8/16-bit PPG ch. 1 (lower)	IRQ09	FFE8 _H	FFE9 _H	L09 [1:0]	
8/16-bit PPG ch. 1 (upper)	IRQ10	FFE6 _H	FFE7 _H	L10 [1:0]	
8/16-bit PPG ch. 2 (upper)	IRQ11	FFE4 _H	FFE5 _H	L11 [1:0]	
8/16-bit PPG ch. 0 (upper)	IRQ12	FFE2 _H	FFE3 _H	L12 [1:0]	
8/16-bit PPG ch. 0 (lower)	IRQ13	FFE0 _H	FFE1 _H	L13 [1:0]	
8/16-bit composite timer ch. 1 (upper)	IRQ14	FFDE _H	FFDF _H	L14 [1:0]	
8/16-bit PPG ch. 2 (lower)	IRQ15	FFDC _H	FFDD _H	L15 [1:0]	
16-bit reload timer ch. 1, MPG (write timing/compare clear), I ² C	IRQ16	FFDA _H	FFDB _H	L16 [1:0]	
16-bit PPG timer ch. 1, MPG (position detection/compare match)	IRQ17	FFD8 _H	FFD9 _H	L17 [1:0]	
8/10-bit A/D converter	IRQ18	FFD6 _H	FFD7 _H	L18 [1:0]	
Time-base timer	IRQ19	FFD4 _H	FFD5 _H	L19 [1:0]	
Watch prescaler	IRQ20	FFD2 _H	FFD3 _H	L20 [1:0]	
External interrupt ch. 8, ch. 9	IRQ21	FFD0 _H	FFD1 _H	L21 [1:0]	
8/16-bit composite timer ch. 1 (lower)	IRQ22	FFCE _H	FFCF _H	L22 [1:0]	
Flash memory	IRQ23	FFCC _H	FFCD _H	L23 [1:0]	Low



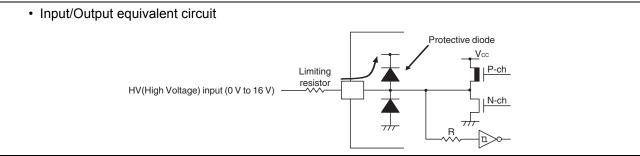
13. Electrical Characteristics

13.1 Absolute Maximum Ratings

D		Rat	ing		D 1
Parameter	Symbol	Min	Max	Unit	Remarks
Power supply voltage*1	V _{CC}	V _{SS} - 0.3	V _{SS} + 6	V	
Input voltage*1	V _I	V _{SS} - 0.3	V _{SS} + 6	V	*2
Output voltage*1	V _O	V _{SS} - 0.3	V _{SS} + 6	V	*2
Maximum clamp current	I _{CLAMP}	-2	+2	mA	Applicable to specific pins*3
Total maximum clamp current	$\Sigma I_{CLAMP} $	_	20	mA	Applicable to specific pins*3
"L" level maximum output cur-	I _{OL1}		15	A	Other than P62 to P67
rent	I _{OL2}	15		- mA	P62 to P67
"L" level average current	I _{OLAV1}	_	4	mA	Other than P62 to P67 Average output current = operating current × operating ratio (1 pin)
L level average current	I _{OLAV2}	_	12		P62 to P67 Average output current = operating current × operating ratio (1 pin)
"L" level total maximum output current	ΣI_{OL}	_	100	mA	
"L" level total average output current	ΣI_{OLAV}	_	50	mA	Total average output current = operating current × operating ratio (Total number of pins)
"H" level maximum output cur-	I _{OH1}	_	-15	A	Other than P62 to P67
rent	I _{OH2}	_	-15	mA	P62 to P67
(i 12	I _{OHAV1}	_	-4		Other than P62 to P67 Average output current = operating current × operating ratio (1 pin)
"H" level average current	I _{OHAV2}	_	-8	– mA	P62 to P67 Average output current = operating current × operating ratio (1 pin)
"H" level total maximum output current	ΣI_{OH}	_	-100	mA	
"H" level total average output current	ΣI_{OHAV}	_	-50	mA	Total average output current = operating current × operating ratio (Total number of pins)
Power consumption	Pd	_	320	mW	
Operating temperature	T _A	-40	+85	°C	
Storage temperature	Tstg	-55	+150	°C	



- *1: The parameter is based on $V_{SS} = 0.0 \text{ V}$.
- *2: V_I and V_O must not exceed V_{CC} + 0.3 V. V_I must not exceed the rated voltage. However, if the maximum current to/from an input is limited by means of an external component, the I_{CLAMP} rating is used instead of the V_I rating.
- *3: Applicable to the following pins: P00 to P07, P10, P11, P13 to P17, P62 to P67, PF0, PF1, PG1 and PG2
 - · Use under recommended operating conditions.
 - · Use with DC voltage (current).
 - The HV (High Voltage) signal is an input signal exceeding the V_{CC} voltage. Always connect a limiting resistor between the HV (High Voltage) signal and the microcontroller before applying the HV (High Voltage) signal.
 - The value of the limiting resistor should be set to a value at which the current to be input to the microcontroller pin when the HV (High Voltage) signal is input is below the standard value, irrespective of whether the current is transient current or stationary current.
 - When the microcontroller drive current is low, such as in low power consumption modes, the HV (High Voltage) input potential
 may pass through the protective diode to increase the potential of the V_{CC} pin, affecting other devices.
 - If the HV (High Voltage) signal is input when the microcontroller power supply is off (not fixed at 0 V), since power is supplied from the pins, incomplete operations may be executed.
 - If the HV (High Voltage) input is input after power-on, since power is supplied from the pins, the voltage of power supply may
 not be sufficient to enable a power-on reset.
 - Do not leave the HV (High Voltage) input pin unconnected.
 - · Example of a recommended circuit



WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

13.2 Recommended Operating Conditions

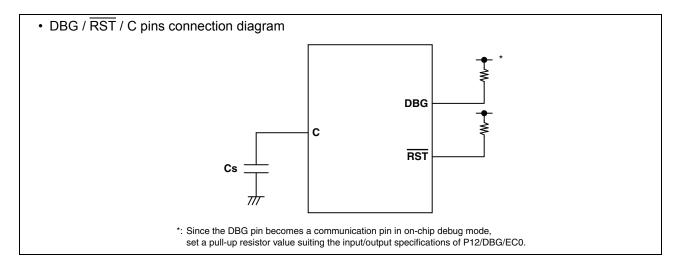
 $(V_{SS} = 0.0 V)$

Parameter	Symbol	Value		Unit	Remarks				
i arameter	Gymbol	Min	Max	Oilit	Remains				
		2.4*1*2 5.5*1 In normal operation		Other than on-chip debug mode					
Power supply	V _{CC}	2.3	5.5	V	Hold condition in stop mode	Other than on-only debug mode			
voltage		2.9	5.5]	In normal operation	On-chip debug mode			
		2.3	5.5		Hold condition in stop mode	- On-chip debug mode			
Smoothing ca- pacitor	C _S	0.022	1	μF	*3				
Operating tem-	т.	-40	+85	°C	Other than on-chip debug mode				
perature	T _A	+5	+35		On-chip debug mode				

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- *1: The value varies depending on the operating frequency, the machine clock and the analog guaranteed range.
- *2: This value becomes 2.88 V when the low-voltage detection reset is used.
- *3: Use a ceramic capacitor or a capacitor with equivalent frequency characteristics. The bypass capacitor for the V_{CC} pin must have a capacitance larger than C_S. For the connection to a smoothing capacitor C_S, see the diagram below. To prevent the device from unintentionally entering an unknown mode due to noise, minimize the distance between the C pin and C_S and the distance between C_S and the V_{SS} pin when designing the layout of a printed circuit board.



WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the

device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges.

Operation outside these ranges may adversely affect reliability and could result in device failure. No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their representatives beforehand.

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13.3 DC Characteristics

 $(V_{CC} = 5.0 \text{ V} \pm 10\%, V_{SS} = 0.0 \text{ V}, T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C})$

		D :	0		Value			5
Parameter	Symbol	Pin name	Condition	Min	Тур	Max	Unit	Remarks
	V _{IHI}	P04, P16, P60, P61	*1	0.7 V _{CC}	_	V _{CC} + 0.3	٧	When CMOS input level (hysteresis input) is selected
"H" level input voltage	V _{IHS}	P00 to P07, P10 to P17, P60 to P67, PF0, PF1, PG1, PG2	*1	0.8 V _{CC}	_	V _{CC} + 0.3	V	Hysteresis input
	V _{IHM}	PF2	_	0.7 V _{CC}	_	V _{CC} + 0.3	V	Hysteresis input
	V _{IL}	P04, P16, P60, P61	*1	V _{SS} - 0.3	_	0.3 V _{CC}	٧	When CMOS input level (hysteresis input) is selected
"L" level input voltage	V _{ILS}	P00 to P07, P10 to P17, P60 to P67, PF0, PF1, PG1, PG2	*1	V _{SS} - 0.3	_	0.2 V _{CC}	V	Hysteresis input
	V _{ILM}	PF2	_	V _{SS} - 0.3	_	0.3 V _{CC}	V	Hysteresis input
Open-drain output application voltage	V _D	P12, P60, P61, PF2	_	V _{SS} - 0.3	_	V _{SS} + 5.5	٧	
"H" level output voltage	V _{OH1}	Output pins other than P12, P60 to P67, PF2	I _{OH} = -4 mA	V _{CC} - 0.5	_	_	V	
	V _{OH2}	P62 to P67	I _{OH} = -8 mA	V _{CC} - 0.5		_	V	
"L" level output	V _{OL1}	Output pins other than P62 to P67	I _{OL} = 4 mA	_	_	0.4	V	
voltage	V _{OL2}	P62 to P67	I _{OL} = 12 mA	_	_	0.4	V	
Input leak cur- rent (Hi-Z out- put leak current)	I _{LI}	All input pins	0.0 V < V _I < V _{CC}	-5	_	+5	μА	When pull-up resistance is disabled
Pull-up resis- tance	R _{PULL}	P00 to P07, P10, P11, P13 to P17, PG1, PG2	V _I = 0 V	25	50	100	kΩ	When pull-up resistance is enabled
Input capaci- tance	C _{IN}	Other than V _{CC} and V _{SS}	f = 1 MHz	_	5	15	pF	



 $(V_{CC} = 5.0 \text{ V} \pm 10\%, V_{SS} = 0.0 \text{ V}, T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C})$

		Pin name	Condition		Value			f Domonika
Parameter	Symbol		Condition	Min	Тур	Max	Unit	Remarks
			V _{CC} = 5.5 V F _{CH} = 32 MHz	_	13	17	mA	Flash memory product (except writing and erasing)
	I _{cc}		F _{MP} = 16 MHz Main clock mode (divided by 2)	F _{MP} = 16 MHz Main clock mode	_	20.5	26.5	mA
				_	15	21	mA	At A/D conversion
	Iccs	V _{CC} (External clock operation)	V_{CC} = 5.5 V F_{CH} = 32 MHz F_{MP} = 16 MHz Main sleep mode (divided by 2)	-	5.5	9	mA	
Power supply	I _{CCL}		V_{CC} = 5.5 V F_{CL} = 32 kHz F_{MPL} = 16 kHz Subclock mode (divided by 2) T_A = +25°C	_	65	153	μΑ	
current*2	I _{CCLS}		V_{CC} = 5.5 V F_{CL} = 32 kHz F_{MPL} = 16 kHz Subsleep mode (divided by 2) T_A = +25°C	_	10	84	μΑ	
	Ісст		V_{CC} = 5.5 V F_{CL} = 32 kHz Watch mode Main stop mode T_A = +25°C	_	5	30	μΑ	
	I _{CCMCR}	V _{CC}	V_{CC} = 5.5 V F_{CRH} = 12.5 MHz F_{MP} = 12.5 MHz Main CR clock mode	_	10	13.2	mA	
	Iccscr	VCC	V _{CC} = 5.5 V Sub-CR clock mode (divided by 2) T _A = +25°C	_	110	410	μА	



 $(V_{CC}$ = 5.0 V±10%, V_{SS} = 0.0 V, T_A = -40°C to +85°C)

Parameter	Symbol	Pin name	Condition		Value		Unit	Remarks
raiametei	raiailletei Sylliboi		Condition	Min	Тур	Max	o i i	Remarks
	I _{CCTS}	V _{CC} (External clock op-	V_{CC} = 5.5 V F_{CH} = 32 MHz Time-base timer mode T_A = +25°C	_	1.1	3	mA	
	I _{CCH}	eration)	$V_{CC} = 5.5 \text{ V}$ Substop mode $T_A = +25^{\circ}\text{C}$	_	3.5	22.5	μΑ	
Power supply current*2	I _{LVD}		Current consumption for low-voltage detection circuit only	_	37	54	μА	
	I _{CRH}	V _{CC}	Current consumption for the main CR oscillator	_	0.5	0.6	mA	
	I _{CRL}		Current consumption for the sub-CR oscillator os- cillating at 100 kHz	_	20	72	μΑ	

^{*1:} The input levels of P04, P16, P60 and P61 can be switched between "CMOS input level" and "hysteresis input level". The input level selection register (ILSR) is used to switch between the two input levels.

- See "4. AC Characteristics: (1) Clock Timing" for F_{CH} and F_{CL}.
- See "4. AC Characteristics: (2) Source Clock/Machine Clock" for F_{MP} and F_{MPL}.

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^{*2: •} The power supply current is determined by the external clock. When the low-voltage detection option is selected, the power-supply current will be the sum of adding the current consumption of the low-voltage detection circuit (I_{LVD}) to one of the value from I_{CC} to I_{CCH}. In addition, when both the low-voltage detection option and the CR oscillator are selected, the power supply current will be the sum of adding up the current consumption of the low-voltage detection circuit, the current consumption of the CR oscillators (I_{CRH}, I_{CRL}) and a specified value. In on-chip debug mode, the CR oscillator (I_{CRH}) and the low-voltage detection circuit are always enabled, and current consumption therefore increases accordingly.



13.4 AC Characteristics

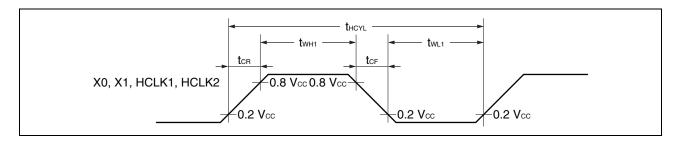
13.4.1 Clock Timing

(V_{CC} = 2.4 V to 5.5 V, V_{SS} = 0.0 V, T_A = -40° C to $+85^{\circ}$ C)

	0	Din name	Condition		Value			B	
Parameter	Symbol	Pin name	Condition	Min	Тур	Max	Unit	Remarks	
		X0, X1	_	1	_	16.25	MHz	When the main oscillation circuit is used	
	_	X0	X1: open	1	_	12	MHz		
	F _{CH}	X0, X1	*	1	_	32.5	MHz	When the main external clock is	
		HCLK1, HCLK2	_	1	_	32.5	MHz	used	
				12.25	12.5	12.75	MHz		
			_	9.8	10	10.2	MHz	When the main CR clock is	
		_		7.84	8	8.16	MHz	used $T_A = -10^{\circ}C \text{ to } +85^{\circ}C$	
Clock frequency	_			0.98	1	1.02	MHz	1 A - 10 0 to 100 0	
	F _{CRH}			12.1875	12.5	12.8125	MHz		
				9.75	10	10.25	MHz	When the main CR clock is	
		_	_	7.8	8	8.2	MHz	used T _A = -40°C to -10°C	
				0.975	1	1.025	MHz	1A40 C 10 - 10 C	
	F _{CL}	V0A V1A		_	32.768	_	kHz	When the sub-oscillation circuit is used	
		X0A, X1A	_	_	32.768	_	kHz	When the sub-external clock is used	
	F _{CRL}	_	_	50	100	200	kHz	When the sub-CR clock is used	
		X0, X1	_	61.5	_	1000	ns	When the main oscillation circuit is used	
		X0	X1: open	83.4	_	1000	ns	When the external clock is used	
Clock cycle time	t _{HCYL}	X0, X1	*	30.8	_	1000	ns		
		HCLK1, HCLK2	_	30.8	_	1000	ns		
	t _{LCYL}	X0A, X1A	_	_	30.5	_	μs	When the subclock is used	
		X0	X1: open	33.4	_	_	ns		
	t _{WH1}	X0, X1	*	12.4	_	_	ns	Mhan the automal clock is	
Input clock pulse width	t _{WL1}	HCLK1, HCLK2	_	12.4	_	_	ns	When the external clock is used, the duty ratio should range between 40% and 60%.	
	t _{WH2} t _{WL2}	X0A	_	_	15.2	_	μs		
		X0	X1: open		_	5	ns		
Input clock rise	t_{CR}	X0, X1	*	_	_	5	ns	When the external clock is used	
time and fall time	t _{CF}	HCLK1, HCLK2	_	_	_	5	ns	When the external clock is used	
CR oscillation start time	t _{CRHWK}	_				80	μs	When the main CR clock is used	
unic	t _{CRLWK}			_	_	10	μs	When the sub-CR clock is used	

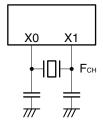
^{*:} The external clock signal is input to X0 and the inverted external clock signal to X1.

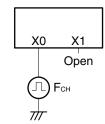


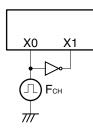


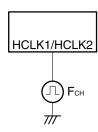
• Figure of main clock input port external connection

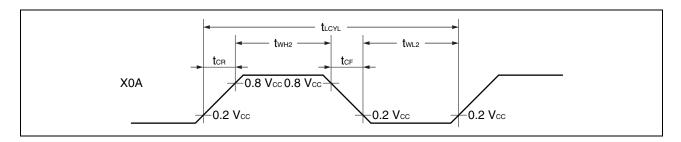
When a crystal oscillator or When the external clock is used When the external clock a ceramic oscillator is used (X1 is open) is used is used





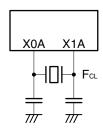




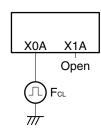


• Figure of subclock input port external connection

When a crystal oscillator or a ceramic oscillator is used



When the external clock is used





13.4.2 Source Clock/Machine Clock

 $(V_{CC}$ = 5.0 V±10%, V_{SS} = 0.0 V, T_A = -40°C to +85°C)

Parameter	Symbol	Pin		Value		Unit	Remarks
Parameter	Symbol	name	Min	Тур	Max	Unit	Remarks
			61.5	_	2000	ns	When the main external clock is used Min: F _{CH} = 32.5 MHz, divided by 2 Max: F _{CH} = 1 MHz, divided by 2
Source clock cy- cle time*1	t _{SCLK}	_	80	_	1000	ns	When the main CR clock is used Min: F _{CRH} = 12.5 MHz Max: F _{CRH} = 1 MHz
			ı	61	ı	μs	When the sub-oscillation clock is used F _{CL} = 32.768 kHz, divided by 2
			ı	20	ı	μs	When the sub-CR clock is used F _{CRL} = 100 kHz, divided by 2
	E		0.5	_	16.25	MHz	When the main oscillation clock is used
Source clock fre-	F _{SP}		1	_	12.5	MHz	When the main CR clock is used
quency		_	_	16.384	_	kHz	When the sub-oscillation clock is used
, ,	F _{SPL}		_	50	_	kHz	When the sub-CR clock is used F _{CRL} = 100 kHz, divided by 2
			61.5	_	32000	ns	When the main oscillation clock is used Min: F _{SP} = 16.25 MHz, no division Max: F _{SP} = 0.5 MHz, divided by 16
Machine clock cy- cle time* ² (minimum instruc-	t _{MCLK}	_	80	_	16000	ns	When the main CR clock is used Min: F _{SP} = 12.5 MHz Max: F _{SP} = 1 MHz, divided by 16
tion execution time)	MCLK		61	_	976.5	μs	When the sub-oscillation clock is used Min: F _{SPL} = 16.384 kHz, no division Max: F _{SPL} = 16.384 kHz, divided by 16
			20	_	320	μs	When the sub-CR clock is used Min: F _{SPL} = 50 kHz, no division Max: F _{SPL} = 50 kHz, divided by 16
	F _{MP}		0.031	_	16.25	MHz	When the main oscillation clock is used
Machine clock fre-	' MP		0.0625	_	12.5	MHz	When the main CR clock is used
quency		_	1.024	_	16.384	kHz	When the sub-oscillation clock is used
, , , , , , , , , , , , , , , , , , ,	F _{MPL}		3.125	_	50	kHz	When the sub-CR clock is used F _{CRL} = 100 kHz

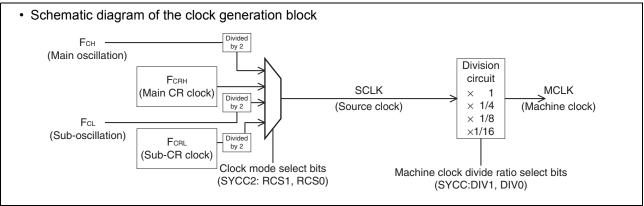
^{*1:} This is the clock before it is divided according to the division ratio set by the machine clock divide ratio select bits (SYCC:DIV1 and DIV0). This source clock is divided to become a machine clock according to the divide ratio set by the machine clock divide ratio select bits (SYCC:DIV1 and DIV0). In addition, a source clock can be selected from the following.

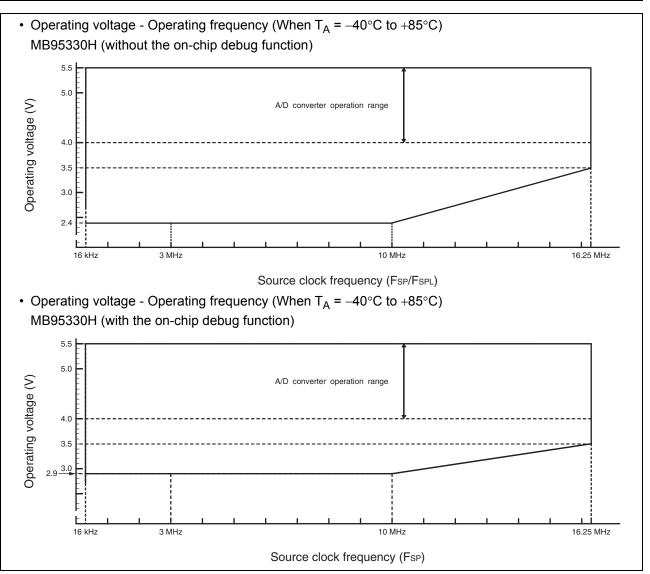
- Main clock divided by 2
- · Main CR clock
- Subclock divided by 2
- Sub-CR clock divided by 2

- Source clock (no division)
- · Source clock divided by 4
- Source clock divided by 8
- · Source clock divided by 16

^{*2:} This is the operating clock of the microcontroller. A machine clock can be selected from the following.









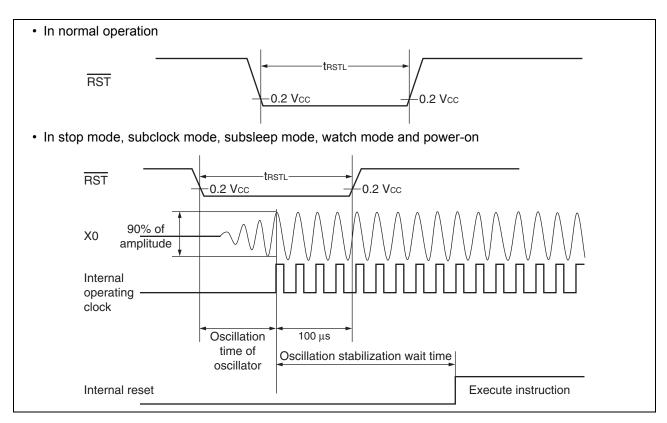
13.4.3 External Reset

	$(V_{CC} = 5.0)$	V±10%,	$V_{SS} = 0$.	0 V, T _A =	$= -40^{\circ}$ C to	+85°C)
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Parameter	Symbol	Value		Unit	Remarks		
Parameter	Syllibol	Min	Max	Oilit	Romaino		
		2 t _{MCLK} *1	_	ns	In normal operation		
RST "L" level pulse width	t _{RSTL}	Oscillation time of the oscillator*2 + 100	_	μs	In stop mode, subclock mode, subsleep mode, watch mode, and power-on		
		100	_	μs	In time-base timer mode		

^{*1:} See "(2) Source Clock/Machine Clock" for t_{MCLK}.

^{*2:} The oscillation time of an oscillator is the time for it to reach 90% of its amplitude. The crystal oscillator has an oscillation time of between several ms and tens of ms. The ceramic oscillator has an oscillation time of between hundreds of μs and several ms. The external clock has an oscillation time of 0 ms. The CR oscillator clock has an oscillation time of between several μs and several ms.

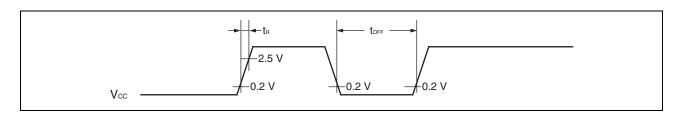


13.4.4 Power-on Reset

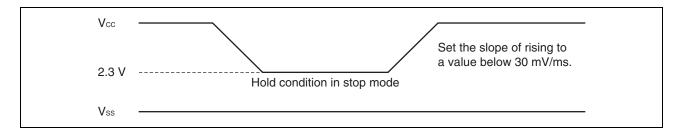
 $(V_{SS} = 0.0 \text{ V}, T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C})$

Parameter	Symbol	Condition	Va	lue	Unit	Remarks	
raiailletei	Syllibol	Condition	Min	Max	Oilit	iveillatus	
Power supply rising time	t _R	_	_	50	ms		
Power supply cutoff time	t _{OFF}	_	1	_	ms	Wait time until power-on	





Note: A sudden change of power supply voltage may activate the power-on reset function. When changing the power supply voltage during the operation, set the slope of rising to a value below within 30 mV/ms as shown below.

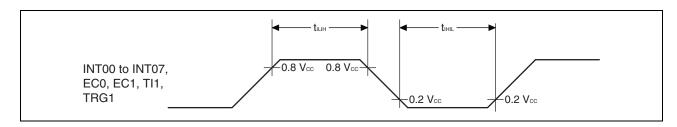


13.4.5 Peripheral Input Timing

$$(V_{CC}$$
 = 5.0 V±10%, V_{SS} = 0.0 V, T_A = -40°C to +85°C)

Parameter	Symbol	Pin name	Val	Unit	
r ai ainetei	Symbol	Fili liaille	Min	Max	Onit
Peripheral input "H" pulse width	t _{ILIH}	INT00 to INT09, EC0, EC1,TI1,	2 t _{MCLK} *	_	ns
Peripheral input "L" pulse width	t _{IHIL}	TRG1	2 t _{MCLK} *	_	ns

*: See "Source Clock/Machine Clock" for t_{MCLK}.





13.4.6 LIN-UART Timing

Sampling is executed at the rising edge of the sampling $clock^{*1}$, and serial clock delay is disabled*². (ESCR register: SCES bit = 0, ECCR register: SCDE bit = 0)

 $(V_{CC}$ = 5.0 V±10%, AV_{SS} = V_{SS} = 0.0 V, T_A = -40°C to +85°C)

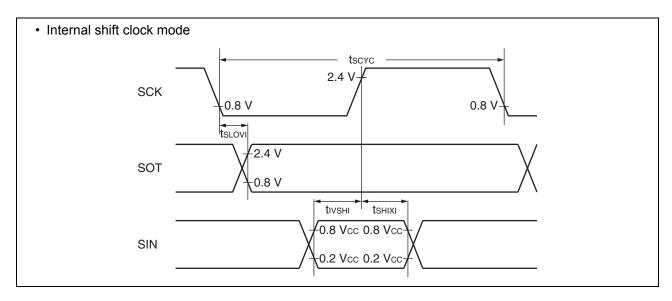
Parameter	Symbol	Pin name	Condition	Va	Unit	
r di dilletei	Symbol	Fill lialite	Condition	Min	Max	Oilit
Serial clock cycle time	t _{SCYC}	SCK		5 t _{MCLK} *3	_	ns
$SCK \downarrow \to SOT \; delay \; time$	t _{SLOVI}	SCK, SOT	Internal clock operation output pin:	-95	+95	ns
$Valid\;SIN\toSCK\;\!\!\uparrow$	t _{IVSHI}	SCK, SIN	$C_L = 80 \text{ pF} + 1 \text{ TTL}$	t _{MCLK} *3 + 190	_	ns
$SCK \uparrow \to valid \; SIN \; hold \; time$	t _{SHIXI}	SCK, SIN		0	_	ns
Serial clock "L" pulse width	t _{SLSH}	SCK		3 t _{MCLK} *3 – t _R	_	ns
Serial clock "H" pulse width	t _{SHSL}	SCK		t _{MCLK} *3 + 95	_	ns
$SCK \downarrow \to SOT$ delay time	t _{SLOVE}	SCK, SOT	External clock	_	2 t _{MCLK} *3 + 95	ns
Valid SIN \rightarrow SCK ↑	t _{IVSHE}	SCK, SIN	operation output pin:	190	_	ns
$SCK \uparrow \to valid \; SIN \; hold \; time$	t _{SHIXE}	SCK, SIN	C _L = 80 pF + 1 TTL	t _{MCLK} *3 + 95	_	ns
SCK fall time	t _F	SCK		_	10	ns
SCK rise time	t _R	SCK		_	10	ns

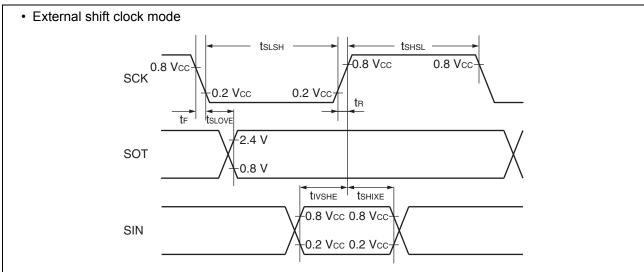
^{*1:} There is a function used to choose whether the sampling of reception data is performed at a rising edge or a falling edge of the serial clock.

^{*2:} The serial clock delay function is a function used to delay the output signal of the serial clock for half the clock.

^{*3:} See "(2) Source Clock/Machine Clock" for t_{MCLK}.









Sampling is executed at the falling edge of the sampling $\operatorname{clock}^{*1}$, and serial clock delay is disabled*². (ESCR register: SCES bit = 1, ECCR register: SCDE bit = 0)

 $(V_{CC} = 5.0 \text{ V} \pm 10\%, V_{SS} = 0.0 \text{ V}, T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C})$

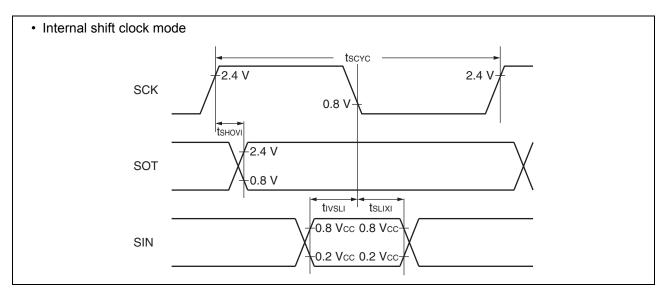
Parameter	Symbol	Pin name	Condition	Va	Unit	
Parameter	Syllibol	Pili lialile	Condition	Min	Max	Ullit
Serial clock cycle time	t _{SCYC}	SCK		5 t _{MCLK} *3	_	ns
$SCK \uparrow \rightarrow SOT$ delay time	t _{SHOVI}	SCK, SOT	Internal clock	-95	+95	ns
Valid SIN → SCK \downarrow	t _{IVSLI}	SCK, SIN	operation output pin: C _L = 80 pF + 1 TTL	t _{MCLK} *3 + 190	_	ns
$SCK \downarrow \rightarrow valid SIN hold time$	t _{SLIXI}	SCK, SIN	_	0	_	ns
Serial clock "H" pulse width	t _{SHSL}	SCK		3 t _{MCLK} *3 – t _R	_	ns
Serial clock "L" pulse width	t _{SLSH}	SCK		t _{MCLK} *3 + 95	_	ns
$SCK \uparrow \rightarrow SOT$ delay time	t _{SHOVE}	SCK, SOT	External clock	_	2 t _{MCLK} *3 + 95	ns
Valid SIN → SCK \downarrow	t _{IVSLE}	SCK, SIN	operation output pin:	190	_	ns
$SCK \downarrow \rightarrow valid SIN hold time$	t _{SLIXE}	SCK, SIN	C _L = 80 pF + 1 TTL	t _{MCLK} *3 + 95	_	ns
SCK fall time	t _F	SCK		_	10	ns
SCK rise time	t _R	SCK		_	10	ns

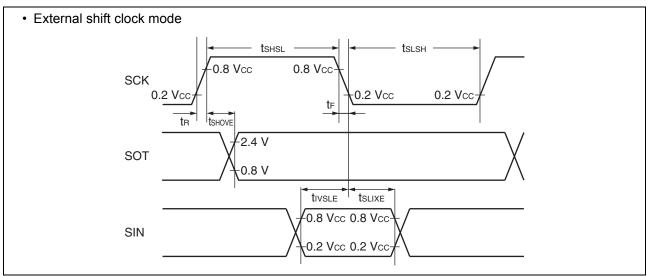
^{*1:} There is a function used to choose whether the sampling of reception data is performed at a rising edge or a falling edge of the serial clock.

^{*2:} The serial clock delay function is a function used to delay the output signal of the serial clock for half the clock.

^{*3:} See "(2) Source Clock/Machine Clock" for t_{MCLK}.









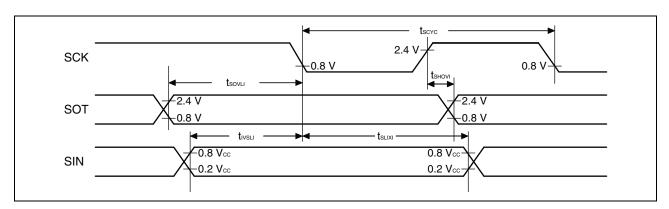
Sampling is executed at the rising edge of the sampling clock*¹, and serial clock delay is enabled*². (ESCR register: SCES bit = 0, ECCR register: SCDE bit = 1)

$$(V_{CC} = 5.0 \text{ V} \pm 10\%, V_{SS} = 0.0 \text{ V}, T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C})$$

Parameter	Symbol	Pin name	Condition	Va	Unit	
raiailletei	Symbol	Fill Hallie	Condition	Min	Max	Oilit
Serial clock cycle time	t _{SCYC}	SCK		5 t _{MCLK} *3	_	ns
$SCK \uparrow \to SOT \ delay\ time$	t _{SHOVI}	SCK, SOT	Internal clock	-95	+95	ns
Valid SIN → SCK \downarrow	t _{IVSLI}	SCK, SIN	operation output pin:	t _{MCLK} *3 + 190	_	ns
$SCK \downarrow \to valid \; SIN \; hold \; time$	t _{SLIXI}	SCK, SIN	C _L = 80 pF + 1 TTL	0	_	ns
$SOT \to SCK \downarrow delay \; time$	t _{SOVLI}	SCK, SOT		_	4 t _{MCLK} *3	ns

^{*1:} There is a function used to choose whether the sampling of reception data is performed at a rising edge or a falling edge of the serial clock.

^{*3:} See "(2) Source Clock/Machine Clock" for t_{MCLK}.



^{*2:} The serial clock delay function is a function that delays the output signal of the serial clock for half clock.



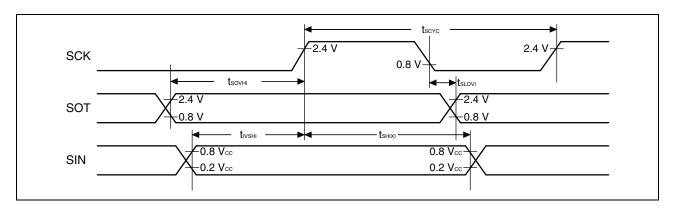
Sampling is executed at the falling edge of the sampling $\operatorname{clock}^{*1}$, and serial clock delay is enabled*². (ESCR register: SCES bit = 1, ECCR register: SCDE bit = 1)

$$(V_{CC} = 5.0 \text{ V} \pm 10\%, V_{SS} = 0.0 \text{ V}, T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C})$$

Parameter	Symbol	Pin name	Condition	Va	Unit	
raidilletei	Syllibol	Fill lialite	Condition	Min	Max	Oilit
Serial clock cycle time	t _{SCYC}	SCK		5 t _{MCLK} *3	_	ns
$SCK \downarrow \to SOT \ delay\ time$	t _{SLOVI}	SCK, SOT	Internal clock operation	-95	+95	ns
Valid SIN → SCK ↑	t _{IVSHI}	SCK, SIN	output pin:	t _{MCLK} *3 + 190	_	ns
$SCK \uparrow \to valid \; SIN \; hold \; time$	t _{SHIXI}	SCK, SIN	C _L = 80 pF + 1 TTL	0	_	ns
$SOT \to SCK \uparrow delay time$	t _{SOVHI}	SCK, SOT		_	4 t _{MCLK} *3	ns

^{*1:} There is a function used to choose whether the sampling of reception data is performed at a rising edge or a falling edge of the serial clock.

*3: See "(2) Source Clock/Machine Clock" for t_{MCLK}.



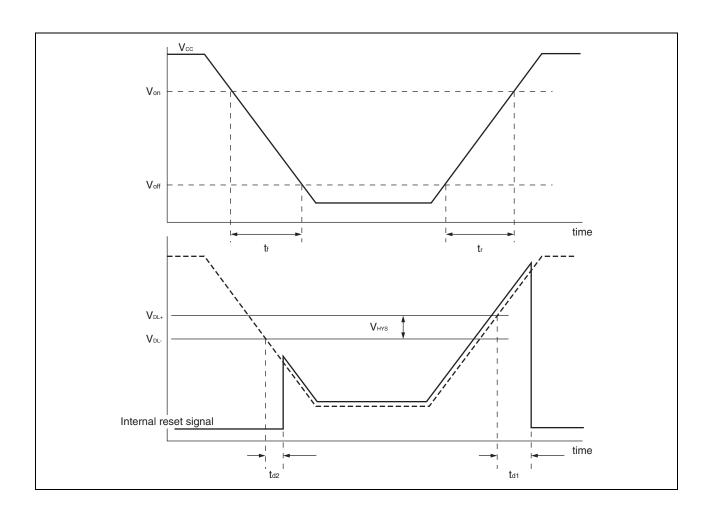
13.4.7 Low-voltage Detection

$$(V_{SS} = 0.0 \text{ V}, T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C})$$

						, 56 , A
Parameter	Symbol	Value			Unit	Remarks
raiailletei	Symbol	Min	Тур	Max	Oilit	Remarks
Release voltage	V _{DL+}	2.52	2.7	2.88	V	At power supply rise
Detection voltage	V _{DL} -	2.42	2.6	2.78	V	At power supply fall
Hysteresis width	V _{HYS}	70	100	_	mV	
Power supply start voltage	V _{off}	_	_	2.3	V	
Power supply end voltage	V _{on}	4.9	_	_	V	
Power supply voltage change time (at power supply rise)	t _r	3000	_	_	μs	Slope of power supply that the reset release signal generates within the rating (V _{DL+})
Power supply voltage change time (at power supply fall)	t _f	300	_	_	μs	Slope of power supply that the reset detection signal generates within the rating (V _{DL} -)
Reset release delay time	t _{d1}	_	_	300	μs	
Reset detection delay time	t _{d2}	_	_	20	μs	

^{*2:} The serial clock delay function is a function that delays the output signal of the serial clock for half clock.





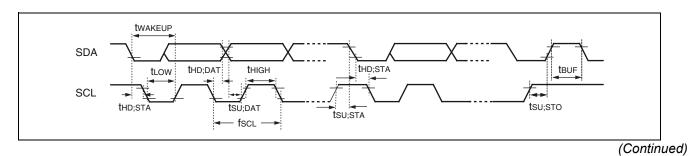


13.4.8 I²C Timing

(V_{CC} = 5.0 V±10%, AV_{SS} = V_{SS} = 0.0 V, T_A = -40° C to $+85^{\circ}$ C)

Parameter	Symbol	Pin name	Condition		an- mode	Fast-mode		Unit
				Min	Max	Min	Max	
SCL clock frequency	f _{SCL}	SCL		0	100	0	400	kHz
(Repeated) START condition hold time SDA \downarrow \rightarrow SCL \downarrow	t _{HD;STA}	SCL, SDA		4.0	_	0.6	_	μs
SCL clock "L" width	t _{LOW}	SCL		4.7	_	1.3	_	μs
SCL clock "H" width	t _{HIGH}	SCL		4.0	_	0.6	_	μs
(Repeated) START condition hold time SCL $\uparrow \rightarrow$ SDA \downarrow	t _{SU;STA}	SCL, SDA	R = 1.7 kΩ,	4.7	_	0.6	_	μs
Data hold time SCL $\downarrow \rightarrow$ SDA $\downarrow \uparrow$	t _{HD;DAT}	SCL, SDA	$C = 50 \text{ pF}^{*1}$	0	3.45 ^{*2}	0	0.9*3	μs
Data setup time SDA $\downarrow\uparrow$ \rightarrow SCL \uparrow	t _{SU;DAT}	SCL, SDA		0.25	_	0.1	_	μs
STOP condition setup time SCL $\uparrow \rightarrow$ SDA \uparrow	t _{su;sto}	SCL, SDA		4	_	0.6	_	μs
Bus free time between STOP condition and START condition	t _{BUF}	SCL, SDA		4.7	_	1.3	_	μs

- *1: R represents the pull-up resistor of the SCL and SDA lines, and C the load capacitor of the SCL and SDA lines.
- *2: The maximum t_{HD;DAT} in the Standard-mode is applicable only when the time during which the device is holding the SCL signal at "L" (t_{LOW}) does not extend.
- *3: A Fast-mode I^2C -bus device can be used in a Standard-mode I^2C -bus system, provided that the condition of $t_{SU;DAT} \ge 250$ ns is fulfilled.





(V_{CC} = 5.0 V±10%, AV_{SS} = V_{SS} = 0.0 V, T_A = $-40^{\circ}C$ to $+85^{\circ}C$)

Parameter	Sym-	Pin	Condition	Valu	ue* ²	Unit	Remarks
raiametei	bol	name	Condition	Min	Max	Oille	Kemarks
SCL clock "L" width	t _{LOW}	SCL		(2 + nm/2)t _{MCLK} - 20	_	ns	Master mode
SCL clock "H" width	t _{HIGH}	SCL		(nm/2)t _{MCLK} – 20	(nm/2)t _{MCLK} + 20	ns	Master mode
START condition hold time	t _{HD;STA}	SCL, SDA		(-1 + nm/2)t _{MCLK} - 20	(-1 + nm)t _{MCLK} + 20	ns	Master mode Maximum value is applied when m, n = 1, 8. Otherwise, the minimum value is applied.
STOP condition setup time	t _{SU;STO}	SCL, SDA		(1 + nm/2)t _{MCLK} - 20	(1 + nm/2)t _{MCLK} + 20	ns	Master mode
START condition setup time	t _{SU;STA}	SCL, SDA		(1 + nm/2)t _{MCLK} - 20	(1 + nm/2)t _{MCLK} + 20	ns	Master mode
Bus free time be- tween STOP condition and START condition	t _{BUF}	SCL, SDA	R = 1.7 kΩ, C = 50 pF* ¹	(2 nm + 4)t _{MCLK} - 20	_	ns	
Data hold time	t _{HD;DAT}	SCL, SDA		3 t _{MCLK} – 20	_	ns	Master mode
Data setup time	t _{SU;DAT}	SCL, SDA		(-2 + nm/2)t _{MCLK} - 20	(–1 + nm/2)t _{MCLK} + 20	ns	Master mode When assuming that "L" of SCL is not extended, the minimum value is applied to first bit of continuous data. Otherwise, the maximum value is ap- plied.
Setup time be- tween clearing interrupt and SCL rising	t _{SU;INT}	SCL		(nm/2)t _{MCLK} – 20	(1 + nm/2)t _{MCLK} + 20	ns	Minimum value is applied to interrupt at 9th SCL↓. Maximum value is applied to the interrupt at the 8th SCL↓.

(Continued)



(Continued)

 $(V_{CC} = 5.0 \text{ V} \pm 10\%, \text{AV}_{SS} = V_{SS} = 0.0 \text{ V}, \text{T}_{A} = -40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C})$

Parameter	Sym-	Pin	Condition	Valu	ue* ²	Unit	Remarks
i didilietei	bol	name	Condition	Min	Max	Oille	Remarks
SCL clock "L" width	t _{LOW}	SCL		4 t _{MCLK} – 20	_	ns	At reception
SCL clock "H" width	t _{HIGH}	SCL		4 t _{MCLK} – 20	_	ns	At reception
START condition detection	t _{HD;STA}	SCL, SDA		2 t _{MCLK} – 20	_	ns	Not detected when 1 t _{MC-} _{LK} is used at reception
STOP condition detection	t _{SU;STO}	SCL, SDA		2 t _{MCLK} – 20	_	ns	Not detected when 1 t _{MC-} _{LK} is used at reception
RESTART condition de- tection condition	t _{SU;STA}	SCL, SDA		2 t _{MCLK} – 20	_	ns	Not detected when 1 t _{MC-} _{LK} is used at reception
Bus free time	t _{BUF}	SCL, SDA		2 t _{MCLK} – 20	_	ns	At reception
Data hold time	t _{HD;DAT}	SCL, SDA	$R = 1.7 kΩ,$ $C = 50 pF^{*1}$	2 t _{MCLK} – 20	_	ns	At slave transmission mode
Data setup time	t _{SU;DAT}	SCL, SDA		t _{LOW} – 3 t _{MCLK} – 20	_	ns	At slave transmission mode
Data hold time	t _{HD;DAT}	SCL, SDA		0	_	ns	At reception
Data setup time	t _{SU;DAT}	SCL, SDA		t _{MCLK} - 20	_	ns	At reception
SDA↓ → SCL↑ (at wakeup function)	t _{WAKEUP}	SCL, SDA		Oscillation stabilization wait time +2 t _{MCLK} - 20	_	ns	

^{*1:} R represents the pull-up resistor of the SCL and SDA lines, and C the load capacitor of the SCL and SDA lines.

- *2: See "(2) Source Clock/Machine Clock" for t_{MCLK}.
 - m represents the CS4 bit and CS3 bit (bit4 and bit3) in the I²C clock control register (ICCR0).
 - n represents the CS2 bit to CS0 bit (bit2 to bit0) in the I²C clock control register (ICCR0).
 - The actual timing of I²C is determined by the values of m and n set by the machine clock (t_{MCLK}) and the CS4 to CS0 bits in the ICCR0 register.
 - · Standard-mode:

m and n can be set to values in the following range: 0.9 MHz < t_{MCLK} (machine clock) < 10 MHz.

The usable frequencies of the machine clock are determined by the settings of m and n as shown below.

 $(m, n) = (1, 8): 0.9 \text{ MHz} < t_{MCLK} \le 1 \text{ MHz}$

 $(m, n) = (1, 22), (5, 4), (6, 4), (7, 4), (8, 4): 0.9 \text{ MHz} < t_{MCLK} \le 2 \text{ MHz}$

 $(m, n) = (1, 38), (5, 8), (6, 8), (7, 8), (8, 8): 0.9 \text{ MHz} < t_{MCLK} \le 4 \text{ MHz}$

 $(m, n) = (1, 98): 0.9 \text{ MHz} < t_{MCLK} \le 10 \text{ MHz}$

· Fast-mode:

m and n can be set to values in the following range: 3.3 MHz < t_{MCLK} (machine clock) < 10 MHz.

The usable frequencies of the machine clock are determined by the settings of m and n as shown below.

(m, n) = (1, 8): 3.3 MHz $< t_{MCLK} \le 4$ MHz

 $(m, n) = (1, 22), (5, 4): 3.3 \text{ MHz} < t_{MCLK} \le 8 \text{ MHz}$

(m, n) = (6, 4): 3.3 MHz < $t_{MCLK} \le 10$ MHz

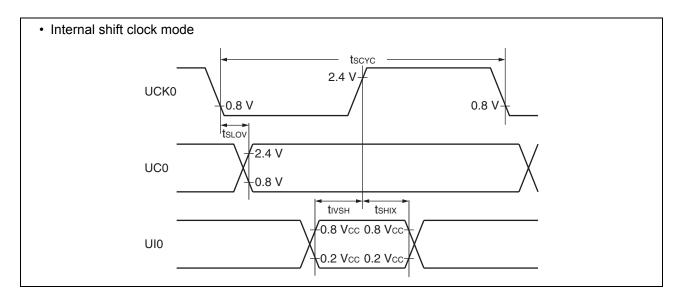


13.4.9 UART/SIO, Serial I/O Timing

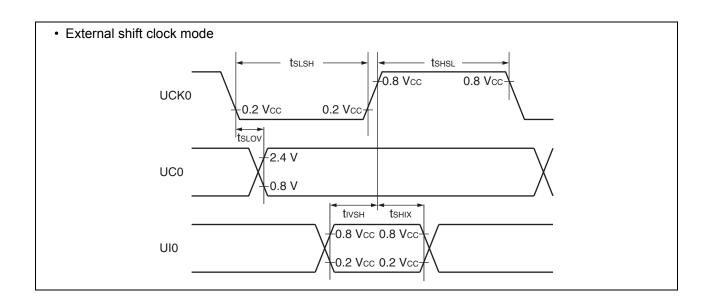
 $(V_{CC} = 5.0 \text{ V} \pm 10\%, \text{ AV}_{SS} = V_{SS} = 0.0 \text{ V}, \text{ T}_{A} = -40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C})$

Parameter	Symbol P	Pin name	Condition	Va	Unit		
Farameter	Symbol	Fill lialile	Condition	Min	Max	Oiiit	
Serial clock cycle time	t _{SCYC}	UCK0		4 t _{MCLK} *	_	ns	
$UCK \downarrow \to UO$ time	t _{SLOV}	UCK0, UO0	Internal clock op-	-190	+190	ns	
Valid UI → UCK ↑	t _{IVSH}	UCK0, UI0	eration	2 t _{MCLK} *	_	ns	
$UCK \uparrow \rightarrow valid \; UI \; hold \; time$	t _{SHIX}	UCK, UI0		2 t _{MCLK} *	_	ns	
Serial clock "H" pulse width	t _{SHSL}	UCK0		4 t _{MCLK} *	_	ns	
Serial clock "L" pulse width	t _{SLSH}	UCK0	External clock op- eration	4 t _{MCLK} *		ns	
$UCK \downarrow \to UO time$	t _{SLOV}	UCK0, UO0		_	190	ns	
Valid UI → UCK ↑	t _{IVSH}	UCK0, UI0		2 t _{MCLK} *		ns	
$UCK \uparrow \rightarrow valid \; UI \; hold \; time$	t _{SHIX}	UCK0, UI0		2 t _{MCLK} *	_	ns	

^{*:} See "(2) Source Clock/Machine Clock" for $t_{\mbox{\scriptsize MCLK}}$.



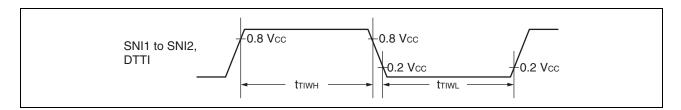




13.4.10 MPG Input Timing

 $(V_{CC} = 5.0 \text{ V} \pm 10\%, \text{ AV}_{SS} = V_{SS} = 0.0 \text{ V}, \text{ T}_{A} = -40^{\circ}\text{C} \text{ to } +85^{\circ}\text{C})$

Parameter	Symbol	Symbol Pin name Condition		Va	lue	Unit	Remarks
Farameter	Symbol Fill hame	Condition	Min	Max	Oilit	Remarks	
Input pulse width	t _{TIWH} t _{TIWL}	SNI0 to SNI2, DTTI	_	4 t _{MCLK}	_	ns	



13.5 A/D Converter

13.5.1 A/D Converter Electrical Characteristics

(V_{CC} = 4.0 V to 5.5 V, V_{SS} = 0.0 V, T_A = $-40^{\circ}C$ to $+85^{\circ}C$)

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Parameter	Symbol		Value	Unit	Remarks	
Faranietei	Syllibol	Min	Тур	Max	Oill	Remarks
Resolution		_	_	10	bit	
Total error		-3	_	+3	LSB	
Linearity error	Ī —	-2.5	_	+2.5	LSB	
Differential linear error		-1.9	_	+1.9	LSB	
Zero transition voltage	V _{OT}	V _{SS} – 1.5 LSB	V _{SS} + 0.5 LSB	V _{SS} + 2.5 LSB	V	

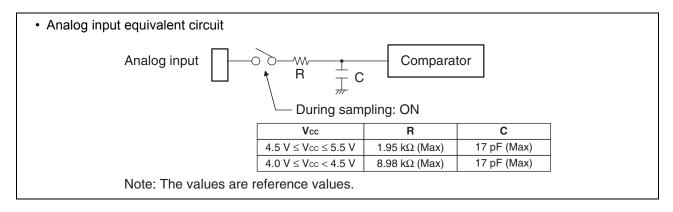


Doromotor	Cumbal		Value	Unit	Domonico	
Parameter	Symbol	Min Typ Max		Max	Unit	Remarks
Full-scale transition voltage	V _{FST}	V _{CC} – 4.5 LSB	V _{CC} – 2 LSB	V _{CC} + 0.5 LSB	V	
Compare time		0.9	_	16500	μs	$4.5 \text{ V} \le \text{V}_{CC} \le 5.5 \text{ V}$
	_	1.8	_	16500	μs	4.0 V ≤ V _{CC} < 4.5 V
Sampling time	_	0.6	_	∞	μs	$4.5 \text{ V} \le \text{V}_{CC} \le 5.5 \text{ V}$, with external impedance < $5.4 \text{ k}\Omega$
		1.2	_	∞	μs	$4.0~\text{V} \leq \text{V}_{CC} < 4.5~\text{V}$, with external impedance < 2.4 k Ω
Analog input current	I _{AIN}	-0.3	_	+0.3	μΑ	
Analog input voltage	V _{AIN}	V _{SS}	_	V _{CC}	V	

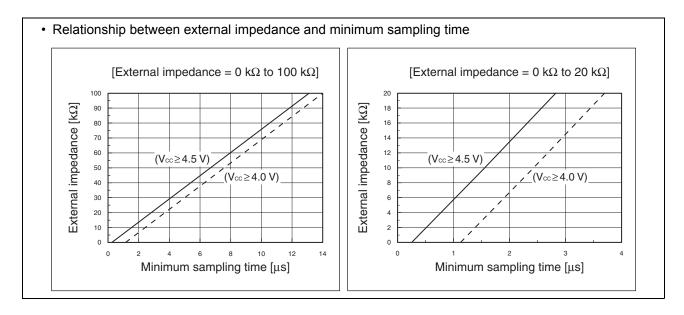
13.5.2 Notes on Using the A/D Converter

■ External impedance of analog input and its sampling time

• The A/D converter has a sample and hold circuit. If the external impedance is too high to keep sufficient sampling time, the analog voltage charged to the capacitor of the internal sample and hold circuit is insufficient, adversely affecting A/D conversion precision. Therefore, to satisfy the A/D conversion precision standard, considering the relationship between the external impedance and minimum sampling time, either adjust the register value and operating frequency or decrease the external impedance so that the sampling time is longer than the minimum value. In addition, if sufficient sampling time cannot be secured, connect a capacitor of about 0.1 µF to the analog input pin.







■ A/D conversion error

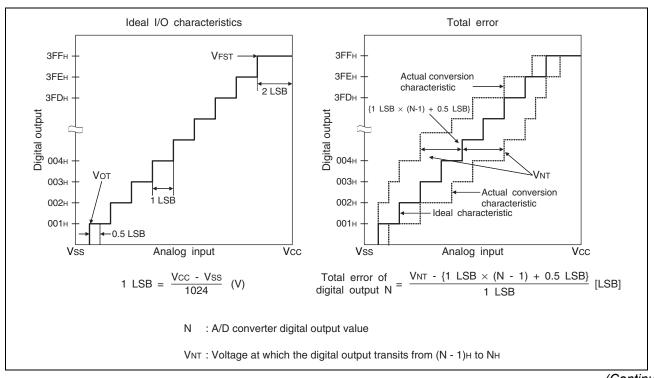
As $|V_{CC}-V_{SS}|$ decreases, the A/D conversion error increases proportionately.

13.5.3 Definitions of A/D Converter Terms

- Resolution
 - It indicates the level of analog variation that can be distinguished by the A/D converter. When the number of bits is 10, analog voltage can be divided into $2^{10} = 1024$.
- Linearity error (unit: LSB)
 It indicates how much an actual conversion value deviates from the straight line connecting the zero transition point ("00 0000 0000" ← → "00 0000 0001") of a device to the full-scale transition point ("11 1111 1111" ← → "11 1111 1110") of the same device.
- Differential linear error (unit: LSB)
 It indicates how much the input voltage required to change the output code by 1 LSB deviates from an ideal value.
- Total error (unit: LSB)

 It indicates the difference between an actual value and a theoretical value. The error can be caused by a zero transition error, a full-scale transition errors, a linearity error, a quantum error, or noise.

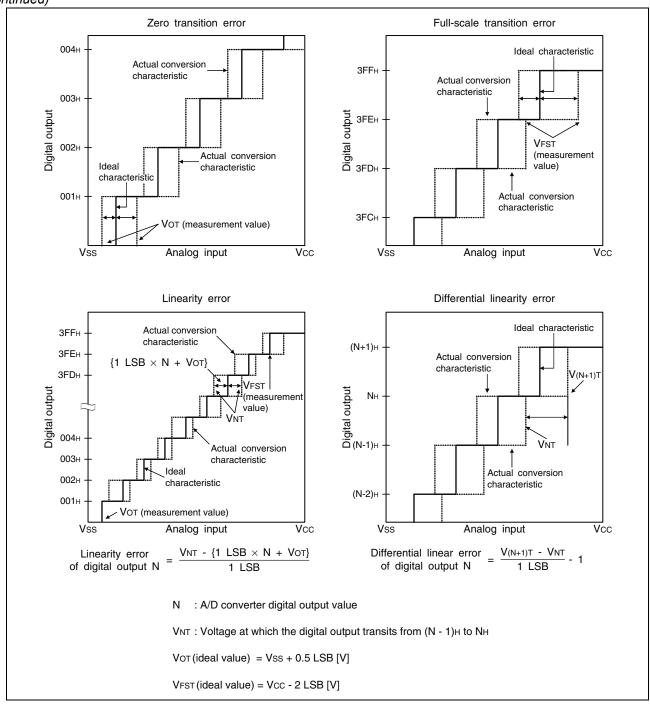




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13.6 Flash Memory Write/Erase Characteristics

Parameter	Value			Unit	Remarks	
raidilletei	Min	Тур	Max	Ullit	Nemarks	
Sector erase time (2 Kbyte sector)	_	0.2*1	0.5* ²	s	The time of writing $00_{\mbox{\scriptsize H}}$ prior to erasure is excluded.	
Sector erase time (16 Kbyte sector)	_	0.5* ¹	7.5* ²	s	The time of writing $00_{\rm H}$ prior to erasure is excluded.	
Byte writing time	_	21	6100* ²	μs	System-level overhead is excluded.	
Erase/write cycle	100000	_	_	cycle		
Power supply voltage at erase/write	3.0	_	5.5	V		
Flash memory data retention time	20* ³	_	_	year	Average T _A = +85°C	

^{*1:} $T_A = +25$ °C, $V_{CC} = 5.0 \text{ V}$, 100000 cycles

^{*2:} $T_A = +85$ °C, $V_{CC} = 3.0$ V, 100000 cycles

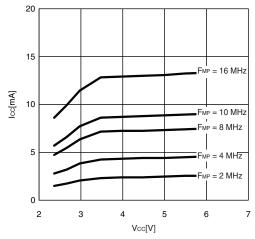
^{*3:} This value is converted from the result of a technology reliability assessment. (The value is converted from the result of a high temperature accelerated test using the Arrhenius equation with the average temperature being +85°C).



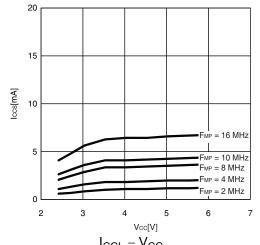
14. Sample Characteristics

■ Power supply current temperature characteristics

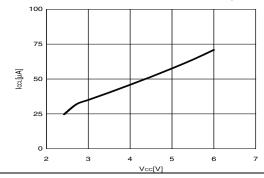
 $I_{CC}-V_{CC} \\ T_A=+25^{\circ}C,\, F_{MP}=2,\,4,\,8,\,10,\,16\,MHz \mbox{ (divided by 2)} \\ Main clock mode with the external clock operating}$



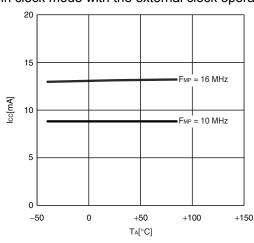
 $I_{CCS}-V_{CC} \\ T_A=+25^{\circ}C,\, F_{MP}=2,\,4,\,8,\,10,\,16\,MHz \mbox{ (divided by 2)} \\ Main sleep mode with the external clock operating}$



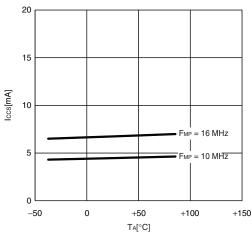
 $I_{CCL} - V_{CC}$ $T_A = +25^{\circ}C$, $F_{MPL} = 16$ kHz (divided by 2) Subclock mode with the external clock operating



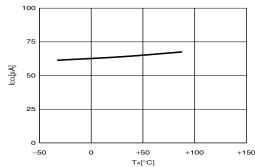
 $I_{CC}-T_A \\ V_{CC}=5.5~V,~F_{MP}=10,~16~MHz~(divided~by~2) \\ Main~clock~mode~with~the~external~clock~operating$



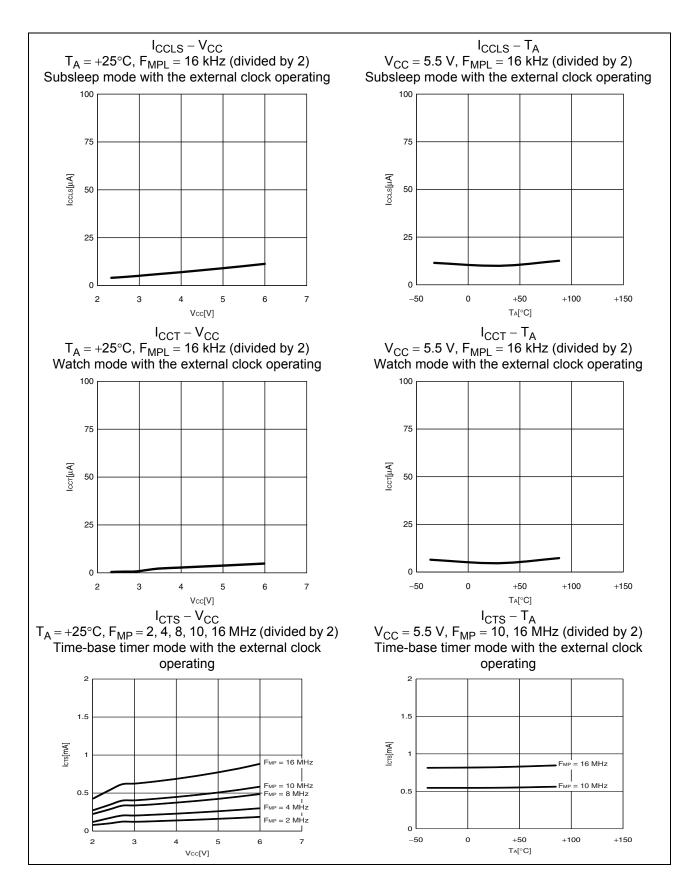
 $I_{CCS}-T_A \\ V_{CC}=5.5~V,~F_{MP}=10,~16~MHz~(divided~by~2) \\ Main~sleep~mode~with~the~external~clock~operating$



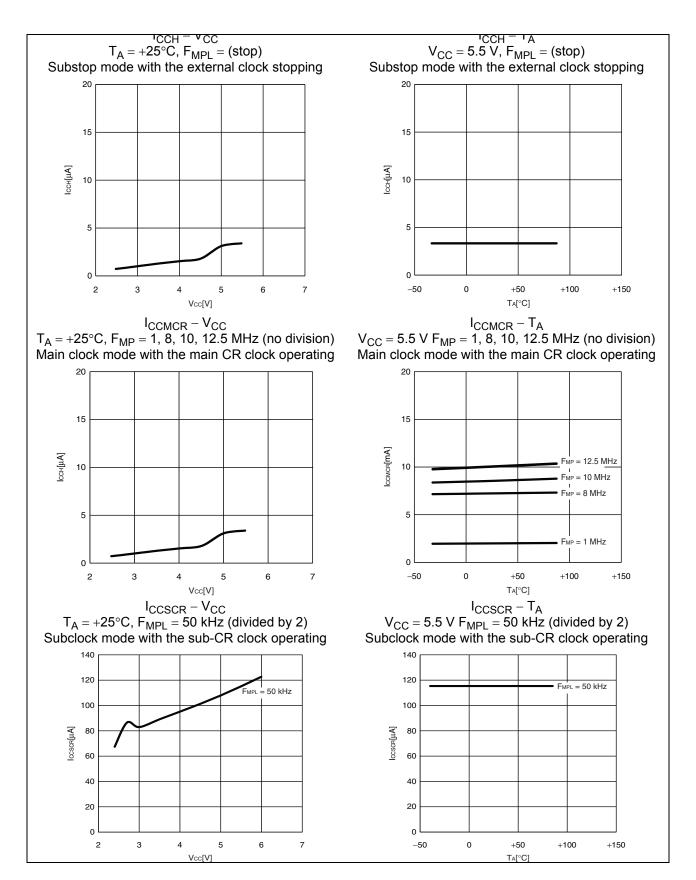
 $I_{CCL}-T_A \\ V_{CC} = 5.5 \text{ V}, \, F_{MPL} = 16 \text{ kHz (divided by 2)} \\ \text{Subclock mode with the external clock operating}$





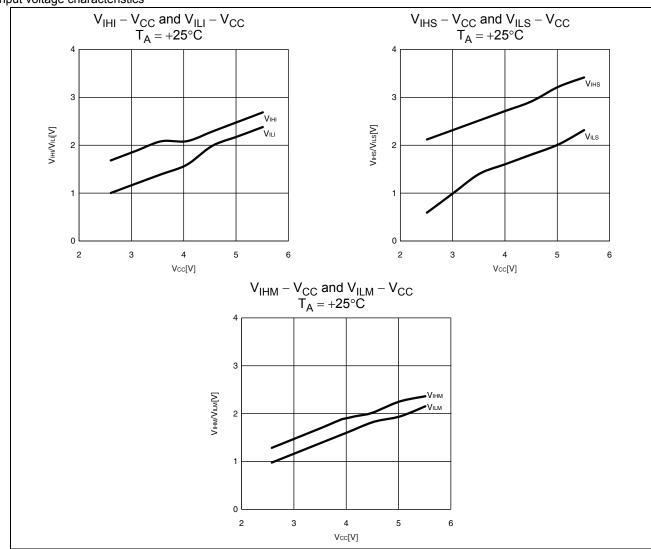






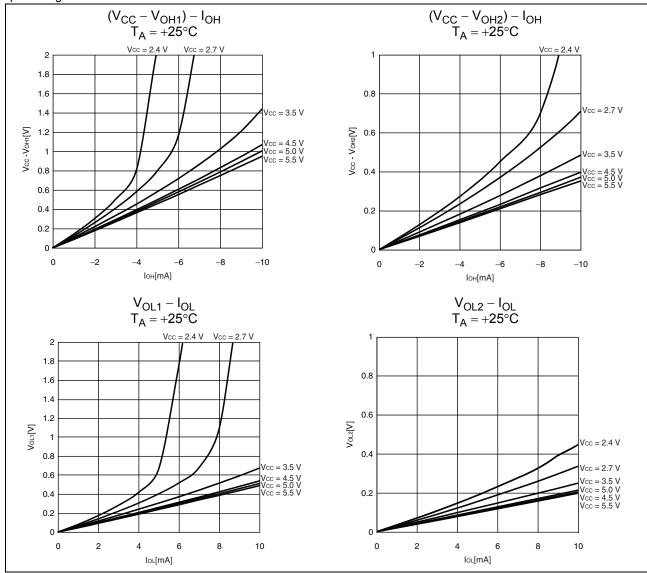


■ Input voltage characteristics

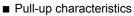


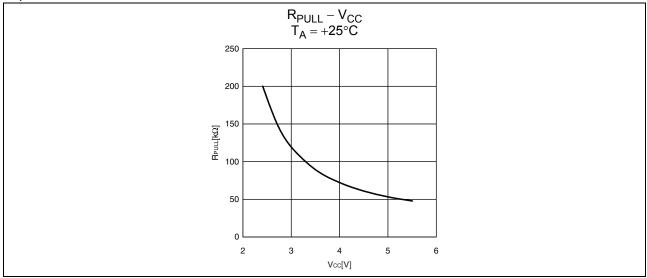


■ Output voltage characteristics









15. Mask Options

No.	Part Number	MB95F332H MB95F333H MB95F334H	MB95F332K MB95F333K MB95F334K		
Selectable/Fixed		Fixed			
1	Low-voltage detection reset	Without low-voltage detection reset	With low-voltage detection reset		
2	Reset	With dedicated reset input	Without dedicated reset input		

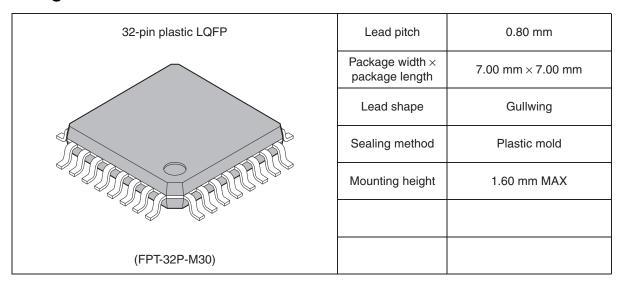


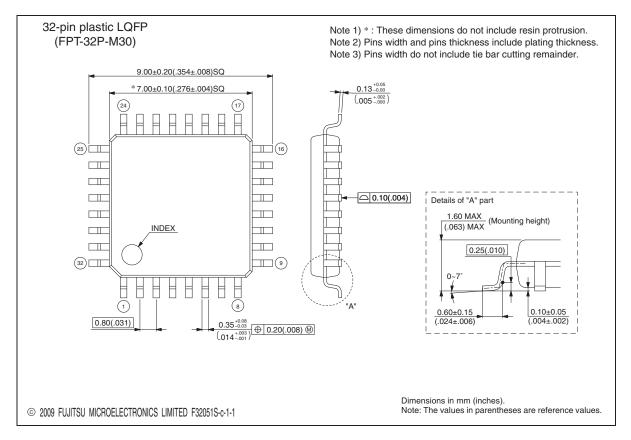
16. Ordering Information

Part Number	Package
MB95F332HPMC-G-SNE2 MB95F332KPMC-G-SNE2 MB95F333HPMC-G-SNE2 MB95F333KPMC-G-SNE2 MB95F334HPMC-G-SNE2 MB95F334KPMC-G-SNE2	32-pin plastic LQFP (FPT-32P-M30)
MB95F332HP-G-SH-SNE2 MB95F332KP-G-SH-SNE2 MB95F333HP-G-SH-SNE2 MB95F333KP-G-SH-SNE2 MB95F334HP-G-SH-SNE2 MB95F334KP-G-SH-SNE2	32-pin plastic SH-DIP (DIP-32P-M06)
MB95F332HWQN-G-SNE1 MB95F332KWQN-G-SNE1 MB95F333HWQN-G-SNE1 MB95F333KWQN-G-SNE1 MB95F334HWQN-G-SNE1 MB95F334KWQN-G-SNE1	32-pin plastic QFN (LCC-32P-M19)



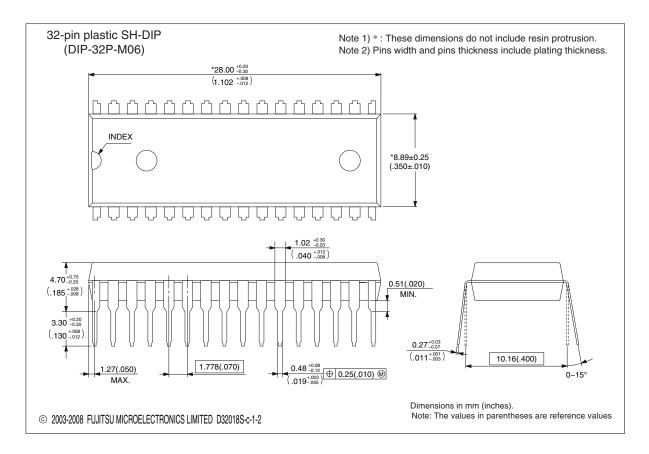
17. Package Dimension







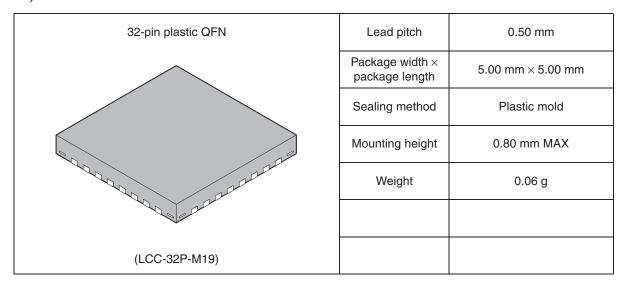
32-pin plastic SH-DIP	Lead pitch	1.778 mm
	Low space	10.16 mm
	Sealing method	Plastic mold
(DIP-32P-M06)		

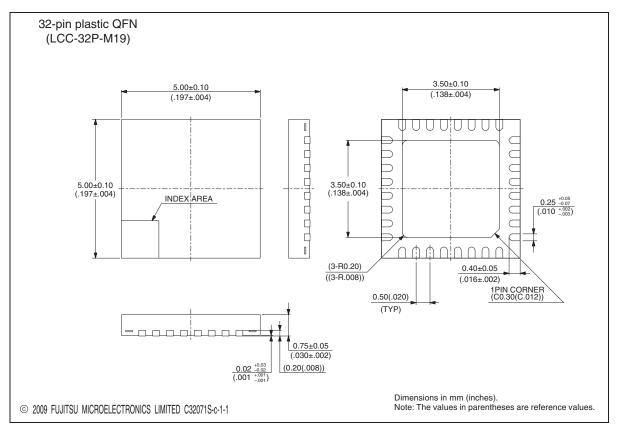


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Document History

	Document Title: MB95F332H/F332K/F333H/F333K/F334H/F334K F ² MC-8FX MB95330H Series 8-bit Microcontrollers Document Number: 002-07522							
Revision	Revision ECN Orig. of Change Date			Description of Change				
**	_	AKIH	04/12/2010	Migrated to Cypress and assigned document number 002-07522. No change to document contents or format.				
*A	5181238	AKIH	04/04/2016	Updated to Cypress template				
*B	5861654	YSAT	08/25/2017	Adapted new Cypress logo				



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